

BMA456 – Data SheetDigital, triaxial acceleration sensor



BMA456 - Data Sheet

Document revision 2.0

Document release date August 2019

Document number BST-BMA456-DS002-00

Technical reference code 0 273 141 282

Notes Data and descriptions in this document are subject to change without

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and may differ from the real product appearance

BMA456 - Basic Description

16 bit, digital, triaxial acceleration sensor with intelligent on-chip motion-triggered interrupt features optimized for wearable applications.

Key features

• Small package size

LGA package (12 pins), footprint 2mm x 2mm, height 0.65 mm

Digital interface

SPI (4-wire, 3-wire), I²C, 2 interrupt pins V_{DDIO} voltage range: 1.2V to 3.6V

Programmable functionality

Acceleration ranges ±2g/±4g/±8g/±16g Low-pass filter bandwidths 684Hz - <8Hz up to a max. output data read out of 1.6 kHz

On-chip FIFO

Integrated FIFO on sensor with 1 kb

· On-chip interrupt features

See "Application note – Wearable feature set" or "Application

note - Hearable feature set"

Ultra-low power

Low current consumption of data acquisition and all

integrated features

(Secondary) Auxiliary Interface

Hub for ext. Magnetometer and data synchronization

RoHS compliant, halogen-free

Typical applications

- Applications with height constrains
- Plug 'n' Play Step-Counter solution with watermark functionality
- Fitness applications / Activity Tracking
- Power management for wearable/hearable applications
- Display on/off and profile switching
- User interface without hardware buttons
- E-compass tilt compensation and data synchronization
- High performance angle measurements

Index of Contents

ВІ	MA456 - Basic Description	2
1.	Specification	8
2.	Absolute maximum ratings	11
3.	Quick Start Guide	12
	Note about using the BMA456:	12
	First application setup examples algorithms:	12
4.	Functional Description	15
	4.1. Supply Voltage and Power Management	16
	4.2. Device Initialization	17
	4.3. Power Modes	18
	4.4. Sensor Data	20
	Acceleration Data	20
	Filter Settings	20
	Accelerometer data processing for performance mode	20
	Accelerometer data processing for low power mode	21
	Data Ready Interrupt	21
	Temperature Sensor	21
	Sensor Time	22
	Configuration Changes	22
	4.5. FIFO	24
	Frames	24
	Conditions and Details	27
	FIFO data synchronization	29
	FIFO synchronization with external interrupts	29
	FIFO Interrupts	30
	FIFO Flush	30
	4.6. Integrated feature set	31

	4.7. General Interrupt Pin configuration	32
	Electrical Interrupt Pin Behavior	32
	Interrupt Pin Mapping	32
	4.8. Auxiliary Sensor Interface	33
	Structure and Concept	33
	Interface Configuration	34
	Setup mode (AUX_IF_CONF.aux_manual_en =0b1)	35
	Data mode (AUX_IF_CONF.aux_manual_en=0)	37
	Delay (Time Offset)	37
	4.9. Sensor Self-Test	38
	4.10.Offset Compensation	39
	Manual Offset Compensation	
	Inline Calibration	39
	4.11. Non-Volatile Memory	40
	4.12.Soft-Reset	40
5.	Register Description	41
5.	5.1. General Remarks	
5.	5.1. General Remarks	41
5.		41
5.	5.1. General Remarks	41 41 45
5.	5.1. General Remarks	41 41 45
5.	5.1. General Remarks 5.2. Register Map Register (0x00) CHIP_ID Register (0x02) ERR_REG	414545
5.	5.1. General Remarks	41454546
5.	5.1. General Remarks	41454646
5.	5.1. General Remarks	4145464647
5.	5.1. General Remarks 5.2. Register Map	4145464647
5.	5.1. General Remarks 5.2. Register Map Register (0x00) CHIP_ID Register (0x02) ERR_REG Register (0x03) STATUS Register (0x0A) DATA_0 Register (0x0B) DATA_1 Register (0x0C) DATA_2 Register (0x0D) DATA_3 Register (0x0E) DATA_4.	414546464747
5.	5.1. General Remarks 5.2. Register Map Register (0x00) CHIP_ID Register (0x02) ERR_REG Register (0x03) STATUS Register (0x0A) DATA_0 Register (0x0B) DATA_1 Register (0x0C) DATA_2 Register (0x0D) DATA_3 Register (0x0E) DATA_4 Register (0x0F) DATA_5	41454646474747
5.	5.1. General Remarks 5.2. Register Map Register (0x00) CHIP_ID Register (0x02) ERR_REG Register (0x03) STATUS Register (0x0A) DATA_0 Register (0x0B) DATA_1 Register (0x0C) DATA_2 Register (0x0D) DATA_3 Register (0x0E) DATA_4 Register (0x0F) DATA_5 Register (0x10) DATA_6	414546464747474748
5.	5.1. General Remarks	41454646474747474848
5.	5.1. General Remarks 5.2. Register Map Register (0x00) CHIP_ID Register (0x02) ERR_REG Register (0x03) STATUS Register (0x0A) DATA_0 Register (0x0B) DATA_1 Register (0x0C) DATA_2 Register (0x0D) DATA_3 Register (0x0E) DATA_4 Register (0x0F) DATA_5 Register (0x10) DATA_6	41454646474747484848

Register (0x14) DATA_10	50
Register (0x15) DATA_11	50
Register (0x16) DATA_12	51
Register (0x17) DATA_13	51
Register (0x18) SENSORTIME_0	52
Register (0x19) SENSORTIME_1	52
Register (0x1A) SENSORTIME_2	53
Register (0x1B) EVENT	53
Register (0x1C) INT_STATUS_0	53
Register (0x1D) INT_STATUS_1	54
Register (0x1E) STEP_COUNTER_0	54
Register (0x1F) STEP_COUNTER_1	54
Register (0x20) STEP_COUNTER_2	54
Register (0x21) STEP_COUNTER_3	54
Register (0x22) TEMPERATURE	55
Register (0x24) FIFO_LENGTH_0	55
Register (0x25) FIFO_LENGTH_1	56
Register (0x26) FIFO_DATA	57
Register (0x27) ACTIVITY_TYPE	57
Register (0x2A) INTERNAL_STATUS	57
Register (0x40) ACC_CONF	58
Register (0x41) ACC_RANGE	59
Register (0x44) AUX_CONF	60
Register (0x45) FIFO_DOWNS	61
Register (0x46) FIFO_WTM_0	61
Register (0x47) FIFO_WTM_1	62
Register (0x48) FIFO_CONFIG_0	62
Register (0x49) FIFO_CONFIG_1	63
Register (0x4B) AUX_DEV_ID	64
Register (0x4C) AUX_IF_CONF	64
Register (0x4D) AUX_RD_ADDR	65
Register (0x4E) AUX_WR_ADDR	65

7.	Pin-out and Connection Diagrams	88
	6.7. Auxiliary Interface	87
	6.6. SPI and I ² C Access Restrictions	87
	6.5. Primary I2C Interface	
	6.4. SPI interface and protocol	
	6.3. Primary Interface I2C/SPI Protocol Selection	
	6.2. Primary Interface	
	6.1. Interfaces	
6.	Digital Interfaces	77
	Register (0x7E) CMD	/6
	Register (0x7D) PWR_CTRL	
	Register (0x7C) PWR_CONF	
	Register (0x73) OFFSET_2	
	Register (0x72) OFFSET_1	
	Register (0x71) OFFSET_0	
	Register (0x70) NV_CONF	
	Register (0x6D) ACC_SELF_TEST	
	Register (0x6B) IF_CONF	
	Register (0x6A) NVM_CONF	
	Register (0x5F) INTERNAL_ERROR	71
	Register (0x5E) FEATURES_IN	
	Register (0x59) INIT_CTRL	70
	Register (0x58) INT_MAP_DATA	69
	Register (0x57) INT2_MAP	68
	Register (0x56) INT1_MAP	68
	Register (0x55) INT_LATCH	68
	Register (0x54) INT2_IO_CTRL	67
	Register (0x53) INT1_IO_CTRL	66
	Register (0x4F) AUX_WR_DATA	66

	7.1.	Pin-out		88
	7.2.		on Diagrams without Auxiliary Interface	
		SPI		89
		I2C		90
	7.3.	Connection	on Diagrams with Auxiliary Interface	90
		SPI		90
		I2C		91
8.	Packa	age		92
			outline dimensions	
	8.2.	Sensing a	axis orientation	93
	8.3.	Landing p	pattern recommendation	95
	8.4.	Marking		96
		Mass _I	production	96
		Engine	eering samples	96
	8.5.	Soldering	guidelines	97
	8.6.	Handling	instructions	98
	8.7.	Tape and	Reel specification	99
	8.8.	Environm	ental safety	100
		Haloge	en content	100
		Interna	al package structure	100
9	l egal	disclaim	er	101
•				
	9.1.	Engineeri	ing samples	101
	9.2.	Product u	ıse	101
	9.3.	Application	on examples and hints	101
10 '	Do o · ·	mont bict	tory and modification	102

1. Specification

Unless stated otherwise, the given values are over lifetime, operating temperature and voltage ranges. Minimum/maximum values are $\pm 3\sigma$.

Parameter Specification

		OPERATING CONDI	TIONS			
Parameter	Symbol	Condition	Min	Тур	Max	Units
Acceleration Range	g FS2g	Selectable		±2		g
	g FS4g	via serial digital interface		±4		g
	g FS8g			±8		g
	g FS16g			±16		g
Supply Voltage Internal Domains	V_{DD}		1.62	1.8	3.6	V
Supply Voltage I/O Domain	V _{DDIO}		1.2	1.8	3.6	V
Voltage Input Low Level	V_{IL}	SPI & I ² C			0.3V _{DDIO}	-
Voltage Input High Level	VIH	SPI & I ² C	0.7V _{DDIO}			-
Voltage Output Low Level	V _{OL}	V_{DDIO} >=1.62V, I_{OL} <=2mA, SPI			0.2V _{DDIO}	-
		V_{DDIO} <1.62V, I_{OL} <=1.5mA, SPI			0.2V _{DDIO}	-
Voltage Output High Level	V _{OH}	V _{DDIO} >=1.62V, I _{OH} <=2mA, SPI	O.8VDDIO			-
		V_{DDIO} <=1.62V, I_{OH} <=1.5mA, SPI	O.8VDDIO			-
Total Supply Current in Performance mode	l _{DD}	Nominal V _{DD} and V _{DDIO} , 25°C, g _{FS4g}		150		μА
Total Supply Current in Suspend Mode	I _{DDsum}	Nominal V _{DD} and V _{DDIO} , 25°C		3.5		μA
Total Supply Current in Low-power Mode	I _{DDIp1}	Nominal V_{DD} and V_{DDIO} , 25°C 50 Hz ODR		14		μА
Power-Up Time	ts_up				1	ms
Non-volatile memory (NVM) write-cycles	п _{NVM}				15	cycles
Operating Temperature	TA		-40		+85	°C

OUTPUT SIGNAL									
Parameter	Symbol	Condition	Min	Тур	Max	Unit			
Sensitivity	S _{2g}	g _{FS2g} , T _A =25°C		16384		LSB/g			
	S _{4g}	g _{FS4g} , T _A =25°C		8192		LSB/g			
	S _{8g}	g _{FS8g} , T _A =25°C		4096		LSB/g			
	S _{16g}	g _{FS16g} , T _A =25°C		2048		LSB/g			
Sensitivity Temperature Drift	TCS			±0.005		%/K			
Zero-g Offset	Off	Nominal V_{DD} and VDD_{IO} , 25°C, g_{FS4g}		±20		mg			
Zero-g Offset Temperature Drift	TCO	X/Y - Axes		±0.2		mg/K			
		Z-Axis		±0.35		mg/K			
Output Data Rate	ODR _{PERF}	Performance mode	12.5		1600	Hz			
	ODR _{12.5}	3dB cutoff frequency of		5.06		Hz			
and BW in Performance mode	ODR ₂₅	the accelerometer according to ODR with		10.12		Hz			
	ODR ₅₀	normal filter mode		20.25		Hz			
	ODR ₁₀₀			40.5		Hz			
	ODR ₂₀₀			80		Hz			
	ODR ₄₀₀			162 (155 for Z axis)		Hz			
	ODR ₈₀₀			324 (262 for Z axis)		Hz			
	ODR ₁₆₀₀			684 (353 for Z axis)		HZ			
Output Data Rate	ODR_{LPM}	Low-power mode	0.78		400	Hz			
Nonlinearity	NL	Nominal V_{DD} and VDD_{IO} , 25°C, g_{FS4g}		±0.5		%FS			
Output Noise Density	N _{dens}	Nominal V_{DD} and VDD_{IO} , $25^{\circ}C$, g_{FS4g}		120		µg/√Hz			
Temperature Sensor Measurement Range	Ts		-40		80	°C			
Temperature Sensor Slope	dTs			1		K/LSB			
Temperature Sensor Offset	OTs	at 23°C		1		K			
Power Supply Rejection Ratio	PSRR			1		mg/50mV			

MECHANICAL CHARACTERISTICS											
Parameter	Symbol	Condition	Min	Тур	Max	Units					
Cross Axis Sensitivity	S	relative contribution between any two of the three axes		±0.5		%					
Alignment Error	EA	relative to package outline		±0.5		O					

2. Absolute maximum ratings

Absolute maximum ratings

Parameter	Condition	Min	Max	Units
Voltage at Supply Pin	V _{DD} Pin	-0.3	4	V
	V _{DDIO} Pin	-0.3	4	V
Voltage at any Logic Pin	Non-Supply Pin	-0.3	V_{DDIO} +0.3, <4	V
Passive Storage Temp. Range	≤ 65% rel. H.	-50	+150	°C
None-volatile memory (NVM)	T = 85°C,	10		у
Data Retention	after 15 cycles			
Mechanical Shock	Duration ≤ 200µs		10,000	g
	Duration ≤ 1.0ms		2,000	g
	Free fall onto hard surfaces		1.8	m
ESD, at any pin	HBM		2	kV
	CDM		500	V
	MM		200	V

Note:

Stress above these limits may cause damage to the device. Exceeding the specified electrical limits may affect the device reliability or cause malfunction.

3. Quick Start Guide

The purpose of this chapter is to help developers who want to start working with the BMA456 by giving you some very basic hands-on application examples to get started.

Note about using the BMA456:

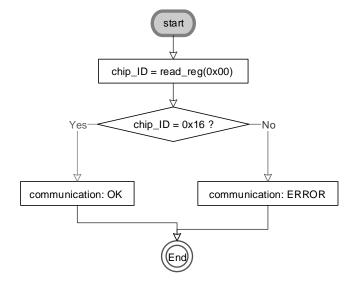
- The communication between application processor and BMA456 will happen either over I2C or SPI interface. For more information about the interfaces, read the related Chapter 6 Digital Interfaces.
- Before starting the test, the device has to be properly connected to the master (AP) and powered up. For more information about it, read the related chapter 7 Pin-out and Connection Diagrams.

First application setup examples algorithms:

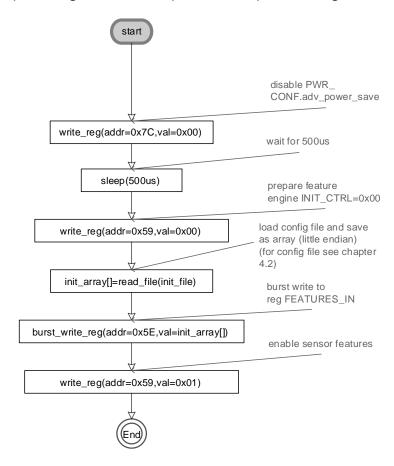
After correct power up by setting the correct voltage to the appropriate external pins, the BMA456 enters automatically into the Power On Reset (POR) sequence. In order to properly make use of the BMA456, certain steps from host processor side are needed. The most typical operations will be explained in the following application examples in form of flow-diagrams.

Example 1: Testing communication with the BMA456 and initializing feature engine

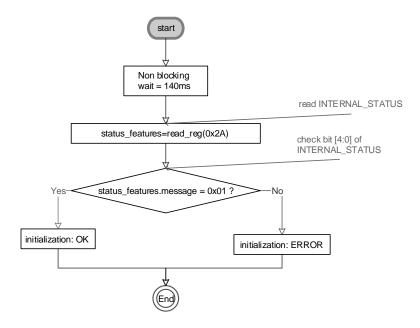
a. -reading chip id (checking correct communication)



b. -performing initialization sequence (interrupt feature engine)

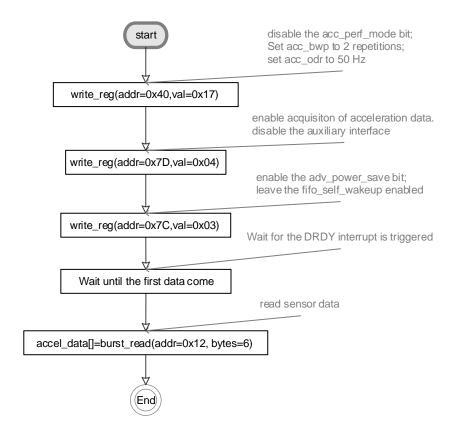


c. -checking the correct status of the interrupt feature engine



Example 2: Reading acceleration data from BMA456 (example: low power mode)

-setting data processing parameters (power, bandwidth, range) and reading sensor data

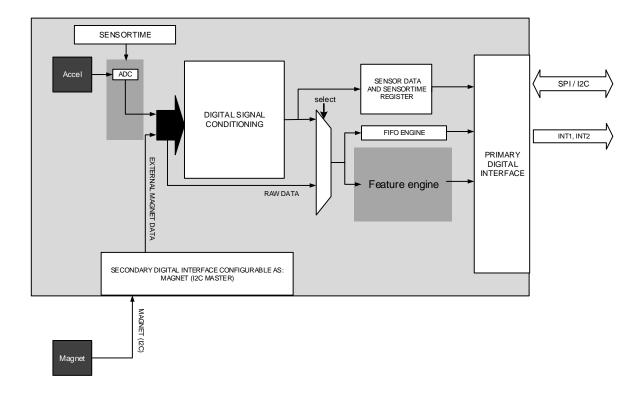


Further steps:

The BMA456 has many more capabilities that are described in this document and include FIFO, power saving modes, synchronization capabilities with host processor, data synchronization and integration with third party sensors, many interrupts generation and more features like step counter, etc.

4. Functional Description

Block Diagram



4.1. Supply Voltage and Power Management

BMA456 has two distinct power supply pins:

- VDD is the main power supply.
- VDDIO is a separate power supply pin used for supplying power for the interface including the auxiliary interface.

There are no limitations with respect to the voltage level applied to the VDD and VDDIO pins, as long as it lies within the respective operating range. Furthermore, the device can be completely switched off (VDD= 0V) while keeping the VDDIO supply within operating range or vice versa. However if the VDDIO supply is switched off, all interface pins (CSB, SDX, SCX) must be kept close to GNDIO potential. The device is reset when the supply voltage applied to at least one supply pin VDD or VDDIO falls below the specified minimum values. No constraints exist for the minimum slew-rate of the voltage applied to the VDD and VDDIO pins.

4.2. Device Initialization

After power up sequence the accelerometer is in suspend mode, device must initialized through the following procedure. Initialization has to be performed as well after every POR or soft reset.

- Disable advanced power save mode: PWR CONF.adv power save =0b0
- Wait for 450 us. The register <u>SENSORTIME_0</u> increments every 39.25 μsec and may be used for accurate timing.
- Write INIT CTRL.init ctrl=0x00
 - Burst write initialization data to Register <u>FEATURES_IN</u>. The configuration file is included
 in the driver available on the Bosch Sensortec website (<u>www.bosch-sensortec.com</u>) or
 from your regional support team. Optionally the configuration file can be written to the
 Register <u>FEATURES_IN</u> in several consecutive burst write access. Every burst write must
 contain an even number of bytes.
 - Optionally:
 Burst read configuration file from Register <u>FEATURES IN</u> and check correctness. Check sensor API for details of timing & length.
- Enable sensor features— write 0x01 into register INIT_CTRL.init_ctrl. This operation must not be performed more than once after POR or softreset.
- Wait until Register INTERNAL_STATUS.message contains the value 0b1. This will happen after at most 140-150 msec.

After initialization sequence has been completed, the device is in configuration mode (power mode). Now it is possible to switch to the required power mode and all features are ready to use as described in chapter 4.

4.3. Power Modes

The power state of the BMA456 is controlled through the registers PWR_CONF and PWR_CTRL. The Register PWR_CTRL enables and disables the accelerometer and the auxiliary sensor. The Register PWR_CONF controls which power state the sensors enter if they are enabled or disabled in the Register PWR_CTRL. The power state impacts the behavior of the sensor with respect to start-up time, available functions, etc. but not the sensor data quality. The sensor data quality is controlled in the Registers ACC_CONF.

In all global power configurations both register contents and FIFO contents are retained.

<u>Low Power Mode</u>: This power configuration aggressively reduces power of the device as much as possible. The low power mode configuration is activated through enabling <u>PWR_CONF.adv_power_save</u>=0b1 and disabling <u>ACC_CONF.acc_perf_mode</u>=0b0. In this configuration these externally user visible features may not be available:

- Register writes need an inter-write-delay of at least 1000 us.
- The sensors log data into the FIFO in performance and low power mode. When the FIFO watermark interrupt is active, the FIFO is accessible for reading in low power mode until a burst read operation on Register FIFO DATA completes when PWR CONF.fifo self wakeup=0b1. When PWR CONF.fifo self wakeup=0b0, the user needs to disable advanced power save mode (PWR CONF.adv power_save=0b0) and wait for 250 µs before reading the FIFO.
- To read out FIFO data w/o a FIFO watermark interrupt, the advanced power save configuration needs to be disabled (<u>PWR_CONF.adv_power_save</u>=0b0)

Please refer to FIFO application note for more details.

The table below shows a few examples with the optimal power configurations

Usecase	ACC_CONF.acc_perf_mode	PWR_CONF.adv_power_save	PWR_CTRL.acc_en	Power consumption
Configuration mode	Х	0	Х	
Suspend (lowest power mode)	x	1	0	Suspend power
Performance mode accel	1	Х	1	Accel works in continuous mode
Low power mode	0	1	1	Depends on ACC_CONF

The <u>PWR_CTRL</u> register is used to enable and disable sensors. Per default, all sensors are disabled. Acceleration sensor must be enabled by setting <u>PWR_CTRL.acc_en</u>=0b1.

The auxiliary sensor functionality is supported only when the auxiliary interface is connected for the auxiliary sensor operation. If the auxiliary interface is not used for auxiliary sensor operation, then the auxiliary sensor interface must remain disabled by setting PWR_CTRL.aux_en=0b0 (default).

To change the power mode of the auxiliary sensor, both the power mode of the auxiliary interface and the auxiliary sensor part needs to be changed, e.g. to set the auxiliary sensor to suspend mode:

- Set the auxiliary sensor interface to suspend in Register PWR_CTRL.aux_en=0b0. Changing the auxiliary sensor interface power mode to suspend does not imply any mode change in the auxiliary sensor.
- The auxiliary sensor part itself must be put into suspend mode by writing the respective configuration bits of the auxiliary sensor part. The power mode of the auxiliary sensor part is controlled by setting the BMA456 auxiliary sensor interface into manual mode by AUX_IF_CONF.aux_manual_en=0b1 and then communicating with the auxiliary sensor part through the BMA456 registers AUX_RD_ADDR, AUX_WR_ADDR, and AUX_WR_DATA. For details see Chapter 4.8.

	Current	Current Consumption* [μΑ] depending on number of averaged samples in low power mode									
ODR	No Avg	Avg 2	Avg 4	Avg 8	Avg 16	Avg 32	Avg 64	Avg 128			
ODR 0.78	3	3	3	4	4	5	7	12			
ODR_1.56	3	3	3	4	4	6	10	15			
ODR_3.125	4	4	4	6	8	12	21	39			
ODR_6.25	4	5	6	8	13	22	40	77			
ODR_12.5	6	7	9	14	23	40	77	152			
ODR_25	8	11	14	24	43	79	152	152			
ODR_50	13	18	27	45	83	152	152	152			
ODR_100	22	32	51	87	152	152	152	152			
ODR_200	42	60	97	152	152	152	152	152			
ODR_400	80	118	152	152	152	152	152	152			

^{*}Current consumption based on limited lab measurements. Only for reference.

4.4. Sensor Data

Acceleration Data

The width of acceleration data is 16 bits given in two's complement representation in the registers DATA_8 to DATA_13. The 16 bits for each axis are split into an MSB upper part and an LSB lower part. Reading the acceleration data registers shall always start with the LSB part. In order to ensure the integrity of the acceleration data, the content of an MSB register is locked by reading the corresponding LSB register (shadowing procedure).

Filter Settings

The accelerometer digital filter can be configured through the Register ACC CONF.

Note:

Illegal settings in configuration registers will result in an error code in Register <u>ERR_REG</u>. The content of the data register is undefined, and if the FIFO is used, it may contain no value.

Accelerometer data processing for performance mode

Performance mode is enabled with <u>ACC_CONF.acc_perf_mode</u>=0b1. In this power mode, the accelerometer data is sampled at equidistant points in the time, defined by the accelerometer output data rate parameter <u>ACC_CONF.acc_odr</u>. The output data rate can be configured in one of eight different valid ODR configurations going from 12.5 Hz up to 1600Hz.

The filter bandwidth shows a 3db cutoff frequency shown in the following table:

Table 12: 3dB cutoff frequency of the accelerometer according to ODR with normal filter mode

Accelerometer ODR [Hz]	12.5	25	50	100	200	400	800	1600
3dB Cutoff frequency [Hz]	5.06	10.12	20.25	40.5	80	162 (155	324	684
						for Z axis)	(262 for Z	(353 for Z
							axis)	axis)

Accelerometer data processing for low power mode

Low power mode can be enabled by PWR_CONF.adv_power_save=0b1 and ACC_CONF.acc_perf_mode=0b0. In this power mode, the accelerometer regularly changes between a suspend power mode phase where no measurement is performed and a performance power mode phase, where data is acquired. The period of the duty cycle for changing between suspend and performance mode will be determined by the output data rate (ACC_CONF.acc_odr). The output data rate can be configured in one of 10 different valid ODR configurations going from 0.78Hz up to 400Hz. The samples acquired during the normal mode phase will be averaged and the result will be the output data. The number of averaged samples can be determined by the parameter ACC_CONF.acc_bwp through the following formula:

averaged samples = 2^{(Val(acc_bwp))} skipped samples = (1600/ODR)-averaged samples

A higher number of averaged samples will result in a lower noise level of the signal, but since the performance power mode phase is increased, the power consumption will also rise.

Data Ready Interrupt

This interrupt fires whenever a new data sample set from accelerometer, or auxiliary sensor is complete. This allows a low latency data readout. In non-latched mode, the interrupt and the flag in Register INT_STATUS_1 are cleared automatically after 1/(3200Hz). If this automatic clearance is unwanted, latched-mode can be used (see chapter 4.7).

In order to enable/use the data ready interrupt map it on the desired interrupt pin via INT_MAP_DATA.

Temperature Sensor

The temperature sensor has 8 bits. The temperature value is defined in Register <u>TEMPERATURE</u> and updated every 1.28 s.

The temperature sensor is always on, when the accelerometer sensor is active.

Value	Temperature
0x7F	150 °C
•••	
0x00	23 °C
•••	
0x81	-104 °C
0x80	Invalid

When there is no valid temperature information available (i.e. last measurement before the time defined above), the temperature indicates an invalid value: 0x80.

Sensor Time

The BMA456 supports the concept of sensortime. Its core element is a free running counter with a width of 24 bits. It increments with a resolution of 39.0625us. The user can access the current state of the counter by reading registers SENSORTIME_0 to SENSORTIME_2.

All sensor events e.g. updates of data registers are synchronous to this sensor time register as defined in the table below. With every update of the data register or the FIFO, a bit *m* in the registers SENSORTIME_0 to SENSORTIME_2 toggles where *m* depends on the output data rate for the data register and the output data rate and the FIFO downsampling rate for the FIFO. The table below shows which bit toggles for which update rate of data register and FIFO

Bit m in sensor_time	23	22	21	20	19	18	17	16
Resolution [s]	327.68	163.84	81.92	40.96	20.48	10.24	5.12	2.56
Update rate [Hz]	0.0031	0.0061	0.012	0.024	0.049	0.10	0.20	0.39

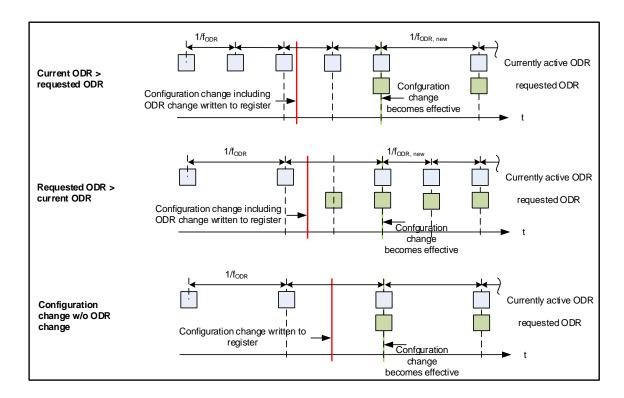
Bit <i>m</i> in sensor_time	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Resolution [ms]	1280	640	320	160	80	40	20	10	5	2.5	1.250	0.625	0.3125	0.156	0.078	0.039
Update rate [Hz]	0.78	1.56	3.125	6.25	12.5	25	50	100	200	400	800	1600	3200			

The sensortime is synchronized with the data capturing in the data register and the FIFO. Between the data sampling and the data capturing there is a delay which depends on the settings in the Register ACC_CONF. The sensortime supports multiple seconds of sample counting and a sub-microsecond resolution, see Register SENSORTIME_0 for details.

Burst reads on the registers <u>SENSORTIME_0</u> to <u>SENSORTIME_2</u> deliver always consistent values, i.e. the value of the register does not change during the burst read.

Configuration Changes

If accelerometer configuration settings in registers <u>ACC_CONF</u>, <u>ACC_RANGE</u>, or <u>AUX_CONF</u> are changed while the accelerometer (<u>PWR_CTRL.acc_en</u> = 0b1) or auxiliary sensor (<u>PWR_CTRL.aux_en</u> = 0b1) is enabled, the configuration changes are not immediately applied. The configuration changes become effective if a sampling event for the currently active ODR coincides with a sampling event for the newly requested ODR on the sensortime sampling grid. In the case where the currently active ODR equals the newly requested ODR, the configuration changes become effective at the next sampling event. See also following figure.



Due to filter settling, some invalid samples can be suppressed in addition after a configuration change.

4.5. FIFO (limited to certain feature set configuration)

Note: FIFO and corresponding registers are not available with every feature set configuration. Please check "Application note – Wearable feature set" or "Application note – Hearable feature set".

The device supports the following FIFO operating modes:

- Streaming mode: overwrites oldest data on FIFO full condition
- FIFO mode: discards newest data on FIFO full condition

The FIFO depth is 1024 byte and supports the following interrupts:

- FIFO full interrupt
- FIFO watermark interrupt

FIFO is enabled with <u>FIFO CONFIG 1.fifo acc en</u>=0b1 (0b0= disabled, to enable FIFO for accelerometer data), or set <u>FIFO CONFIG 1.fifo aux en</u>=0b1 (0b0=disabled, to enable the FIFO for the auxiliary interface (magnetometer)).

Frames

The FIFO captures data in frames, which consist of a header and a payload. The FIFO can be configured to skip the header (headerless mode) in which case only payload is stored.

- In header mode (standard configuration) each regular frame consists of a one byte header describing properties of the frame, (which sensors are included in this frame) and the data itself. Beside the regular frames, there are control frames.
- In headerless mode the FIFO contains sampled data only.

Header mode

The header has a length of 8 bit and the following format:

Bit	7	6	5	4	3	2	1	0
Content	fh_mode<	1:0>	fh_parm<3	3:0>			fh_ext<1:0	>

These fh_mode and fh_parm and fh_ext fields are defined below

fh_mode<1:0>	Definition	fh_parm <3:0>	fh_ext<1:0>
0b10	Regular	Enabled sensors	Tag of INT2 and INT1
0b01	Control	Control opcode	
0b00 and 0b11	Reserved	Na	

fh _parm=0b0000 is invalid for regular mode, a header of 0x80 indicates an uninitialized frame.

In a regular frame, fh_parm frame defines which sensors are included in the data part of the frame. The format is

Name	fh_parm<3:0>			
Bit	3	2	1	0
Content	Reserved	FIFO aux data	Reserved	FIFO acc data

When FIFO_<sensor x>_data is 0b1 (0b0) data for sensor x is included (not included) in the data part of the frame.

The fh_ext<1:0> field are used for external tagging.

The data format for data frames is identical to the format defined for the Register (0x0A) DATA 0 to Register (0x17) DATA 13 register. Only frames which contain data of at least one sensor will be written into the FIFO. E.g. fh_parm=0b0101 the data in the frame are shown below. If the read burst length is less than 8 byte, the number of auxiliary sensor data in the frame is reduced to the burst length.

DATA[X]	Acronym	
X=0	AUX_0	copy of register Val(<u>AUX_RD_ADDR</u>) in auxiliary sensor register map
X=1	AUX_1	copy of register Val(<u>AUX_RD_ADDR</u>)+1 in auxiliary sensor register map
X=2	AUX_2	copy of register Val(<u>AUX_RD_ADDR</u>)+2 in auxiliary sensor register map
X=3	AUX_3	copy of register Val(<u>AUX_RD_ADDR</u>)+3 in auxiliary sensor register map
X=4	AUX_4	copy of register Val(<u>AUX_RD_ADDR</u>)+4 in auxiliary sensor register map
X=5	AUX_5	copy of register Val(<u>AUX_RD_ADDR</u>)+5 in auxiliary sensor register map
X=6	AUX_6	copy of register Val(<u>AUX_RD_ADDR</u>)+6 in auxiliary sensor register map
X=7	AUX_7	copy of register Val(<u>AUX_RD_ADDR</u>)+7 in auxiliary sensor register map
X=8	ACC_X<7:0> (LSB)	
X=9	ACC_X<15:8> (MSB)	
X=10	ACC_Y<7:0> (LSB)	
X=11	ACC_Y<15:8> (MSB)	
X=12	ACC_Z<7:0> (LSB)	
X=13	ACC_Z<15:8> (MSB)	

Headerless mode

When the data rates of all enabled sensor elements are identical, the FIFO header may be disabled in FIFO_CONFIG_1.fifo_header_en.

The headerless mode supports only regular frames. To be able to distinguish frames from each other, all frames must have the same size. For this reason, any change in configuration that have an impact to frame size or order of data within a frame will cause an instant flush of FIFO, restarting capturing of data with the new settings.

If the auxiliary sensor interface is enabled, the number of auxiliary sensor bytes in a FIFO frame is always <u>AUX_IF_CONF.aux_rd_burst</u> bytes (see chapter 4.8). If the burst length is less than 8, BMA456 will pad the values read form the auxiliary sensor. E.g. if <u>AUX_IF_CONF.aux_rd_burst</u>=0b01 (2 Bytes), a frame with auxiliary sensor and accelerometer data will look like

DATA[X]	Acronym	
X=0	AUX_0	copy of register Val(<u>AUX_RD_ADDR.read_addr</u>) in auxiliary sensor register map
X=1	AUX_1	copy of register Val(<u>AUX_RD_ADDR.read_addr</u> +1) in auxiliary sensor register map
X=2	Padding byte	Undefined value
X=3	Padding byte	Undefined value
X=4	Padding byte	Undefined value
X=5	Padding byte	Undefined value
X=6	Padding byte	Undefined value
X=7	Padding byte	Undefined value
X=8	ACC_X<7:0> (LSB)	
X=9	ACC_X<15:8> (MSB)	
X=10	ACC_Y<7:0> (LSB)	
X=11	ACC_Y<15:8> (MSB)	
X=12	ACC_Z<7:0> (LSB)	
X=13	ACC_Z<15:8> (MSB)	

Conditions and Details

Frame rates

The frame sampling rate of the FIFO is defined by the maximum output data rate of the sensors enabled for FIFO sampling. The FIFO sampling configuration is set in register <u>FIFO_CONFIG_0</u> to <u>FIFO_CONFIG_1</u>. It is possible to select filtered or pre-filtered data as an input to the FIFO. If unfiltered data are selected in register <u>FIFO_DOWNS.acc_fifo_filt_data</u> for the accelerometer, the sample rate is 1600 Hz. The input data rate to the FIFO can be reduced by selecting a down-sampling factor 2^k in register <u>FIFO_DOWNS.acc_fifo_downs</u>, where k=[0,1..7].

FIFO Overflow

In the case of overflow the FIFO can either stop recording data or overwrite the oldest data. The behavior is controlled by Register FIFO_CONFIG_0.fifo_stop_on_full. When FIFO_CONFIG_0.fifo_stop_on_full. When eader mode is enabled, the skip frame is prepended at the next FIFO readout, when the free FIFO space falls below the maximum size frame.

If <u>FIFO_CONFIG_0.fifo_stop_on_full_</u> =0b1, the newest frame may be discarded, if the free FIFO space falls below the maximum size frame. If header mode is enabled, a skip frame is prepended at the next FIFO readout (which is **not** the position where the frame(s) have been discarded). During a FIFO read operation of the host, no data at the FIFO tail may be dropped. If the host reads the FIFO with a slower rate than it is filled, it may happen that the sensor needs to drop new data, even when <u>FIFO_CONFIG_0.fifo_stop_on_full_</u> =0b0. These events are recorded in the Register ERR_REG.fifo_err.

Control frames

Control frames are only supported in header mode. There are a number of control frames defined through the *fh_parm* field. These are shown in below.

A skip frame indicates the number of skipped frames after a FIFO overrun occurred, a sensortime frame contains the sensortime when the last sampled frame stored in the FIFO is read, a FIFO input config frames indicates a change in sensor configuration which affects the sensor data. The FIFO fill level is contained in registers <u>FIFO LENGTH 1.fifo byte counter 13 8</u> and <u>FIFO LENGTH 0.fifo byte counter 7 0</u> and includes the control frames, with the exception of the sensortime frame.

fh_mode<3:0>	Definition
0x0	Skip Frame
0x1	Sensortime Frame
0x2	Fifo_Input_Config Frame
0x3	Reserved
0x4	Sample Drop Frame
0x5 - 0x7	Reserved

Skip Frame (fh_parm=0x0):

In the case of FIFO overflows, a skip_frame is prepended to the FIFO content, when read out next time. The data for the frame consists of one byte and contains the number of skipped frames. When more than 0xFF frames have been skipped, 0xFF is returned. A skip frame is expected always as first frame in a FIFO read burst.

Sensortime Frame (fh_parm=0x1):

The data for the sensortime frame consists content of the Register <u>SENSORTIME_0</u> to <u>SENSORTIME_2</u> when the last byte of the last sample frame was read. A sensortime frame is always expected as last frame in the FIFO. A sensortime frame is only sent if the FIFO becomes empty during the burst read. A sensortime frame does not consume memory in the FIFO. Sensortime frames are enabled (disabled) by setting <u>FIFO_CONFIG_0.fifo_time_en</u> to 0b1 (0b0).

Fifo_Input_Config Frame (fh_parm=0x2):

Whenever the filter configuration of the FIFO input data sources changes, a FIFO input config frame is inserted into the FIFO, before the configuration change becomes active. E.g. when the bandwidth for the accelerometer filter is changed in Register ACC_CONF, a FIFO input config frame is inserted before the first frame with accelerometer data with the new bandwidth configuration. The FIFO input config frame contains one byte of data with the format

Bit	7	6	5	4	3	2	1	0
Content	reserv	ed	aux_	aux_	reserved	reserved	acc_	acc_
			if ch	conf ch			range ch	conf ch

aux_if_ch: A write to Register AUX_IF_CONF, AUX_RD_ADDR, or AUX_WR_ADDR becomes

active.

aux_conf_ch: A write to Register <u>AUX_CONF</u> becomes active. acc_range_ch: A write to Register <u>ACC_RANGE</u> becomes active.

acc conf ch: A write to Register ACC CONF or acc FIFO filt data or acc FIFO downsampling in

Register FIFO DOWNS becomes active.

Sample Drop Frame

A sample drop frame has always one byte payload, defined through

Bit	7	6	5	4	3	2	1	0
Content	reser	ved				aux_drop	reserved	acc_ drop

Sample drop frame will be inserted after a Fifo_Input_Config frame at the ODR tick at which the sample was dropped and only if no other sensor provides a valid sample at this ODR tick. If another sensor provides valid data, the data of this sensor is just not included and the appropriate header bit of the data frame is not set.

Sample drop frames will be inserted only for transition phases after configuration changes, not for samples dropped between sensor enable and first valid sample. For a detailed description of configuration changes see Section 4.4, Subsection "Configuration Changes".

FIFO Partial frame reads

When a frame is only partially read through the Register <u>FIFO_DATA</u> it will be repeated completely with the next access both in headerless and in header mode. In headermode, this includes the header. In the case of a FIFO overflow between the first partial read and the second read attempt, the frame may be deleted.

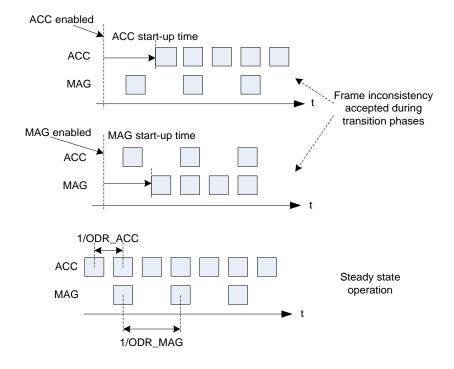
FIFO overreads

When more data are read from the FIFO than it contains valid data, 0x8000 is returned in headerless mode. While in header mode 0x0080 is returned, where 0x80 indicates an invalid frame.

FIFO data synchronization

All sensor data are sampled with respect to a common ODR time grid. Even if a different ODR is selected for the acceleration and the magnetic sensor the data remains synchronized: If a frame contains a sample from a sensor element with ODR x, then it must contain also samples of all sensor elements with an ODR y>=x. This applies for steady state operation. In transition phases, it is more important not to lose data, therefore exceptions are possible if the sensor elements with ODR y>=x do not have data, e.g. due to a sensor configuration change.

FIFO Data Synchronization Scheme in the following figure illustrates the steady state and transient operating conditions.



FIFO synchronization with external interrupts

External interrupts may be synchronized into the FIFO data. For this operation mode the FIFO CONFIG 1.fifo tag int1 en and/or FIFO CONFIG 1.fifo tag int2 en need to be enabled, as well as INT1 IO CTRL.input en and/or INT2 IO CTRL.input en. The fh_ext field in FIFO header will then be set according to the signal at the INT1/INT2 inputs.

FIFO Interrupts

The FIFO supports two interrupts, a FIFO full interrupt and a watermark interrupt:

- The FIFO full interrupt is issued when the FIFO fill level is above the full threshold. The full threshold is reached just before the last two frames are stored in the FIFO.
- The FIFO watermark is issued when the FIFO fill level is equal or above a watermark defined in Register FIFO WTM_0 and FIFO_WTM_1.

In order to enable/use the FIFO full or watermark interrupts map them on the desired interrupt pin via INT_MAP_DATA.

Both interrupts are suppressed when a read operation on the Register <u>FIFO_DATA</u> is ongoing. Latched FIFO interrupts will only get cleared, if the status register gets read and the fill level is below the corresponding FIFO interrupt (full or watermark).

FIFO Flush

The user can trigger a FIFO reset by writing the command fifo_flash (0xB0) in <u>CMD</u>. Automatic resets are only performed in the following cases:

- A sensor is enabled or disabled in headerless mode
- A transition between headerless and headermode or vice versa has occurred.
- Size of auxiliary sensor data in a frame changed in header or headerless mode

4.6. Integrated feature set

For configuration and details please check "Application note – Wearable feature set" or "Application note – Hearable feature set"

4.7. General Interrupt Pin configuration

Electrical Interrupt Pin Behavior

Both interrupt pins INT1 and INT2 can be configured to show the desired electrical behavior. Interrupt pins can be enabled in INT1_IO_CTRL.output_en respectively INT2_IO_CTRL.output_en. The characteristic of the output driver of the interrupt pins may be configured with bits INT1_IO_CTRL.od and INT2_IO_CTRL.od. By setting these bits to 0b1, the output driver shows open-drive characteristic, by setting the configuration bits to 0b0, the output driver shows push-pull characteristic.

The electrical behavior of the Interrupt pins, whenever an interrupt is triggered, can be configured as either "active-high" or "active-low" via INT1 IO CTRL.lvl respectively INT2 IO CTRL.lvl.

Both interrupt pins can be configured as input pins via INT1_IO_CTRL.input_en respectively INT2_IO_CTRL.input_en. This is necessary when FIFO tag feature is used. If both are enabled, the input (e.g. marking FIFO) is driven by the interrupt output.

BMA456 supports edge and level triggered interrupt inputs, this can be configured through INT1_IO_CTRL.edge_ctrl respectively INT2_IO_CTRL.edge_ctrl.

BMA456 supports non-latched and latched interrupts modes for data-ready, FIFO full and FIFO watermark. The mode is selected by INT_LATCH.int_latch. The feature interrupts described in chapter **Error! Reference source not found.** support only latched mode described below.

In latched mode an asserted interrupt status in INT_STATUS_1 and the selected pin are cleared if the corresponding status register is read. If more than one interrupt pin is used in latched mode, all interrupts in INT_STATUS_0 should be mapped to one pin and all interrupts in INT_STATUS_1 should be mapped to the other pin. If just one interrupt pin is used all interrupts may be mapped to this pin. If the activation condition still holds when it is cleared, the interrupt status is asserted again when the interrupt condition holds again.

In the non-latched mode (only for data-ready, FIFO full and FIFO watermark) the interrupt status bit and the selected pin are reset as soon as the activation condition is not valid anymore.

Interrupt Pin Mapping

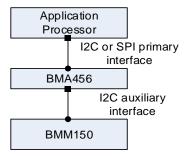
In order, for the Host to react to the features output, they can be mapped to the external pin INT1 or pin INT2, by setting the corresponding bits from the registers INT1 MAP, respectively INT2 MAP.

To disconnect the features outputs to the external pins, the same corresponding bits must be reset, from the registers, INT1_MAP, respectively INT2_MAP.

Once a feature triggered the output pin, the Host can read out the corresponding bit from the register, INT_STATUS_0 (Flature Interrupts) or INT_STATUS_1 (FIFO and data ready).

4.8. Auxiliary Sensor Interface

The auxiliary interface allows to attach one auxiliary sensor (e.g. magnetometer) on dedicated auxiliary sensor interface as shown below.



6-DOF Solution w/ BMA456 and BMM150

Structure and Concept

The BMA456 controls the data acquisition of the auxiliary sensor and presents the data to the application processor through the primary I2C or SPI interface. No other I2C master or slave devices must be attached to the auxiliary sensor interface.

The BMA456 autonomously reads the sensor data from a compatible auxiliary sensor without intervention of the application processor and stores the data in its data registers and FIFO. The initial setup of the auxiliary sensor after power-on is done through indirect addressing (in setup mode as described in following section).

The main benefits of the auxiliary sensor interface are

- Synchronization of sensor data of auxiliary sensor and accelerometer. This results in an improved sensor data fusion quality.
- Usage of the BMA456 FIFO for auxiliary sensor data (BMM150 does not have a FIFO). This is important for monitoring applications.

Interface Configuration

The configuration registers that control the auxiliary sensor interface operation, are only affecting the interface to the auxiliary sensor, not the configuration of the accelerometer sensor itself (this must be done in setup mode).

There are three basis configurations/ modes of the auxiliary sensor interface:

- No auxiliary sensor access
- Setup mode: Auxiliary sensor access in manual mode
- Data mode: Auxiliary sensor access through hardware readout loop.

The setup of the auxiliary sensor itself must be done through the primary interface using indirect addressing in setup mode. When collecting sensor data, the BMA456 autonomously triggers the measurement of the auxiliary sensor using the auxiliary sensor forced mode and the data readout from the auxiliary sensor (data mode).

In setup mode, the auxiliary sensor may be configured and trim data may be read out from the auxiliary sensor. In the data mode the auxiliary sensor data are continuously copied into BMA456 registers and may be read out from BMA456 directly over the primary interface. For a BMM150 magnetometer, these are the auxiliary sensor data itself and Hall resistance, temperature is not required. The table below shows how to configure these three modes using the registers PWR CTRL, and AUX IF CONF.aux manual en.

Mode	AUX_IF_CONF.aux_manual_en	PWR_CONF.adv_power_save	PWR_CTRL.aux_en
No auxiliary	1	1	0
sensor			
access			
Setup mode	1	0	0
Data mode	0	x	1

The auxiliary sensor interface mode may be enabled by setting bit <u>IF_CONF.if_mode</u> according to the following table.

IF_CONF.if_mode	Result
0	Secondary IF disabled (default)
1	AuxIF enabled

The auxiliary sensor interface operates at 400 kHz. This results in an I2C readout delay of about 250 us for 10 bytes of data.

The I2C slave address of the auxiliary sensor is defined in AUX_DEV_ID.i2c_device_addr.

Setup mode (AUX_IF_CONF.aux_manual_en = 0b1)

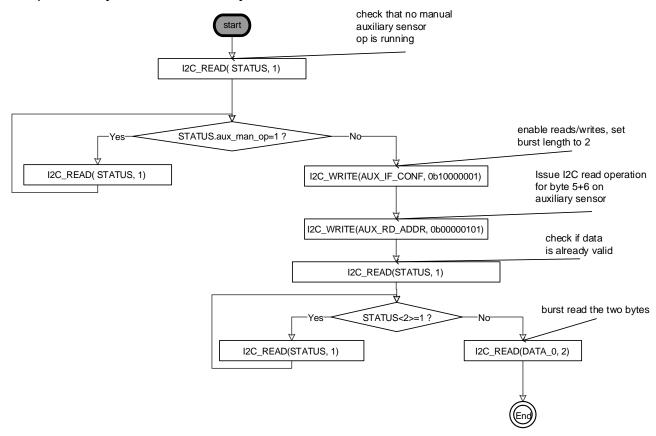
Through the primary interface the auxiliary sensor may be accessed using indirect addressing through the AUX_* registers. <u>AUX_RD_ADDR</u> and <u>AUX_WR_ADDR</u> define the address of the register to read/write in the auxiliary sensor register map and triggers the operation itself, when the auxiliary sensor interface is enabled through <u>PWR_CTRL.aux_en</u>.

For reads, the number of data bytes defined in <u>AUX_IF_CONF.aux_rd_burst</u> are read from the auxiliary sensor and written into the BMA456 Register <u>DATA_0</u> to <u>DATA_7</u>. For writes only single bytes are written, independent of the settings in <u>AUX_IF_CONF.aux_rd_burst</u>. The data for the I2C write to auxiliary sensor must be stored in <u>AUX_WR_DATA</u> before the auxiliary sensor register address is written into <u>AUX_WR_ADDR</u>.

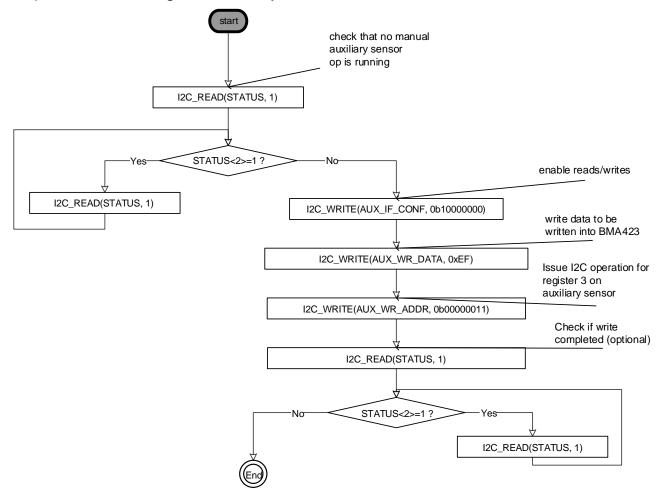
When a read or write operation is triggered by writing to <u>AUX_RD_ADDR</u> and <u>AUX_WR_ADDR</u>, <u>STATUS.aux_man_op</u> is set and it is reset when the operation is completed. For reads the <u>DATA_0</u> to <u>DATA_7</u> contains the read data, for writes <u>AUX_WR_DATA</u> may be overwritten again.

Configuration phase of the auxiliary sensor.

Example: Read bytes 5 and 6 of auxiliary sensor



Example: Write 0xEF into register 3 of auxiliary sensor



Data mode (AUX_IF_CONF.aux_manual_en=0)

AUX_RD_ADDR.read_addr defines the address of the data register from which to read the number of data bytes configured in AUX_IF_CONF.aux_rd_burst from AUX_0... AUX_7 data of the auxiliary sensor. These data are stored in the DATA_0 up to DATA_7 register. The data ready status is set in STATUS.drdy_aux, it is typically cleared through reading one of the DATA_0 to DATA_7 registers.

AUX_WR_ADDR.write_addr defines the register address of auxiliary sensor to start a measurement in forced mode in the auxiliary sensor register map. The delay (time offset) between triggering an auxiliary sensor measurement and reading the measurement data is specified in AUX_CONF.aux_offset. Reading of the data is done in a single I2C read operation with a burst length specified in AUX_IF_CONF.aux_rd_burst. For BMM150 AUX_IF_CONF.aux_rd_burst should be set to 0b11, i.e. 8 bytes. If AUX_IF_CONF.aux_rd_burst is set to a value lower than 8 bytes, the remaining auxiliary sensor data in the Register DATA_0 to DATA_7 and the FIFO are undefined.

It is recommended to disable the auxiliary sensor interface (IF CONF.if mode=0b0) before setting up AUX_RD_ADDR.read_addr and AUX_WR_ADDR.write_addr for the data mode. This does not put the auxiliary sensor itself into suspend mode but avoids gathering unwanted data during this phase. Afterwards the auxiliary sensor interface can be enabled (IF_CONF.if_mode=0b1) again.

Delay (Time Offset)

BMA456 supports starting the measurement of the sensor at the auxiliary sensor interface between 2.5 and 37.5 ms before the Register DATA are updated. This offset is defined in AUX_CONF.aux_offset. If set to 0b0, the measurement is done right after the last Register DATA update, therefore this measurement will be included in the next register DATA update.

4.9. Sensor Self-Test

The BMA456 has a comprehensive self test function for the MEMS element by applying electrostatic forces to the sensor core instead of external accelerations. By actually deflecting the seismic mass, the entire signal path of the sensor can be tested. Activating the self-test results in a static offset of the acceleration data; any external acceleration or gravitational force applied to the sensor during active self-test will be observed in the output as a superposition of both acceleration and self-test signal. Before the self-test is enabled the g-range should be set to 8g. The self-test is activated for all axes by writing ACC_SELF_TEST.acc_self_test_en = 1b1. The self-test is disabled by writing ACC_SELF_TEST.acc_self_test_en = 1b0. It is possible to control the direction of the deflection through bit ACC_SELF_TEST.acc_self_test_sign. The excitation occurs in positive (negative) direction if ACC_SELF_TEST.acc_self_test_sign = 1b1 ('b0). The amplitude of the deflection has to be set low by writing ACC_SELF_TEST.acc_self_test_amp = 1b0. After the self-test is enabled, the user should wait 50ms before interpreting the acceleration data.

In order to ensure a proper interpretation of the self-test signal it is recommended to perform the self-test for both (positive and negative) directions and then to calculate the difference of the resulting acceleration values. The table below shows the minimum differences for each axis in order for the self test to pass. The actually measured signal differences can be significantly larger.

Self-test: Resulting minimum difference signal for BMA456.

	x-axis signal	y-axis signal	z-axis signal
BMA456	1800 mg	1800 mg	1800 mg

It is recommended to perform a reset of the device after a self-test has been performed. If the reset cannot be performed, the following sequence must be kept to prevent unwanted interrupt generation: disable interrupts, change parameters of interrupts, wait for at least 50ms, and enable desired interrupts.

The recommended self test procedure is as follows:

- 1. Enable accelerometer with register PWR CTRL.acc en=1b1.
- 2. Set ±8g range in register ACC RANGE.acc range
- 3. Set self test amplitude to low by setting ACC_SELF_TEST.acc_self_test_amp = 1b0
- Set <u>ACC_CONF.acc_odr=1600Hz</u>, Continuous sampling mode, <u>ACC_CONF.acc_bwp=norm_avg4</u>, <u>ACC_CONF.acc_perf_mode=1b1</u>.
- 5. Wait for > 2 ms
- 6. Enable self-test and set positive self-test polarity (ACC_SELF_TEST.acc_self_test_sign= 1b1)
- 7. Wait for > 50ms
- 8. Read and store positive acceleration value of each axis from registers DATA_8 to DATA_13
- Enable self-test and set <u>negative</u> self-test polarity (<u>ACC_SELF_TEST.acc_self_test_sign</u>= 1b0)
- 10. Wait for > 50ms
- 11. Read and store negative acceleration value of each axis from registers DATA_8 to DATA_13
- 12. Calculate difference of positive and negative acceleration values and compare against threshold values

4.10. Offset Compensation

BMA456 offers manual compensation as well as inline calibration.

Offset compensation is performed with pre-filtered data, and the offset is then applied to both, pre-filtered and filtered data. If necessary the result of this computation is saturated to prevent any overflow errors (the smallest or biggest possible value is set, depending on the sign). The public offset compensation Registers OFFSET_0 to OFFSET_2 are images of the corresponding registers in the NVM. With each image update the contents of the NVM registers are written to the public registers. The public registers can be overwritten by the user at any time. The offset compensation registers have a width of 8 bit using two's complement notation. The offset resolution (LSB) is 3.9 mg and the offset range is +- 0.5 g. Both are independent of the range setting. Offset compensation needs to be enabled through NV_CONF.acc_off_en = 0b1

Manual Offset Compensation

The contents of the public compensation Register OFFSET_0 to OFFSET_2 may be set manually via the digital interface. After modifying the Register OFFSET_0 to OFFSET_2 the next data sample is not valid.

Offset compensation needs to be enabled through NV_CONF.acc_off_en.

Inline Calibration

For certain applications, it is often desirable to calibrate the offset once and to store the compensation values permanently. This can be achieved by using manual offset compensation to determine the proper compensation values and then storing these values permanently in the NVM.

Each time the device is reset, the compensation values are loaded from the non-volatile memory into the image registers and used for offset compensation.

4.11. Non-Volatile Memory

The registers <u>NV_CONF</u> and <u>OFFSET_0</u> to <u>OFFSET_2</u> have an NVM backup which are accessible by the user.

The content of the NVM is loaded to the image registers after a reset (either POR or softreset). As long as the image update is in progress, STATUS.cmd_rdy is 0b0, otherwise it is 0b1.

The image registers can be read and written like any other register.

Writing to the NVM is a 4-step procedure:

- 1. Set PWR CONF.adv power save = 0b0
- 2. Write the new contents to the image registers.
- 3. Write 0b1 to bit NVM_CONF.nvm_prog_en in order to unlock the NVM.
- 4. Write *nvm_prog* to the <u>CMD</u> register to trigger the write process.
- 5. Write 0b0 to bit NVM_CONF.nvm_prog_en in order to lock the NVM, after the write process is completed

Writing to the NVM always renews the entire NVM contents. It is possible to check the write status by reading <u>STATUS.cmd_rdy</u>. While <u>STATUS.cmd_rdy</u> = 0b0, the write process is still in progress; when <u>STATUS.cmd_rdy</u> = 0b1, writing is completed. An NVM write cycle can only be initiated, if <u>PWR_CONF.adv_power_save</u> = 0b0.

Until boot phase is finished (after POR or softreset), the serial interface is not operational. The NVM shadow registers must not be accessed during an ongoing NVM command (initiated through the Register CMD). In all other cases, register can be read or written.

As long as an NVM read (during sensor boot and soft reset) or an NVM write is ongoing, writes to sensor registers are discarded, reads return the Register STATUS independent of the read address.

4.12. Soft-Reset

A softreset can be initiated at any time by writing the command *softreset* (0xB6) to register CMD. The softreset performs a fundamental reset to the device which is largely equivalent to a power cycle. Following a delay, all user configuration settings are overwritten with their default state (setting stored in the NVM) wherever applicable. This command is functional in all operation modes but must not be performed while NVM writing operation is in progress.

5. Register Description

5.1. General Remarks

Registers can be read and written in all power configurations with the exception of <u>FEATURES_IN</u> and <u>FIFO_DATA</u> which need <u>PWR_CONF.adv_power_save</u> set to 0b0.

5.2. Register Map

	read/write		rea	id only		write o	only		reserved	
Register	Register	Default								ID:
Address	Name	Value	7	6	5	4	3	2	1	0
0x7E	<u>CMD</u>	0x00				Cr	md			
0x7D	PWR_CT RL	0x00			reserved			acc_en	reserved	aux_en
0x7C	PWR_C ONF	0x03			res	erved			fifo_self_ wakeup	adv_pow er_save
0x7B	-	•				rese	erved			
	-	1				rese	erved			
0x74	-	1				rese	erved			
0x73	OFFSET 2	0x00				off_a	acc_z			
0x72	<u>OFFSET</u> <u>1</u>	0x00				off_a	acc_y			
0x71	OFFSET 0	0x00				off_a	acc_x			
0x70	NV CON <u>F</u>	0x00		rese	erved		acc_off_ en	i2c_wdt_ en	i2c_wdt_ sel	spi_en
0x6F	-	-				rese	erved			
0x6E	-	-				rese	erved			
0x6D	ACC SE LF TES I	0x00		rese	erved		acc_self_ test_amp	acc_self_ test_sign	reserved	acc_self_ test_en
0x6C	-	-				rese	erved			
0x6B	IF CON E	0x00		reserved		if_mode		reserved		spi3
0x6A	NVM_C ONF	0x00			res	erved			nvm_pro g_en	reserved
0x69	-	1				rese	erved			
	-	•				rese	erved			
0x60	-	-				rese	erved			
0x5F	INTERN AL ERR OR	0x00		reserved int_err_2				int_err_1	reserved	
0x5E	FEATUR ES_IN	0x00	features_in							
0x5D	-			reserved						
	-	-		reserved						
0x5A	-	-				rese	erved			

	· · · · · · · · · · · · · · · · · · ·									
0x59	INIT_CT RL	0x90				init_	_ctrl			
0x58	INT_MA P_DATA	0x00	reserved	int2_drdy	int2_fwm	int2_ffull	reserved	int1_drdy	int1_fwm	int1_ffull
0x57	INT2_MA	0x00			Applica		Vearable fea	ture set		
0.57	<u>P</u>	0,000	or Application note – Hearable feature set							
	11174 144			Application note – Wearable feature set						
0x56	INT1_MA P	0x00					or			
					Applica	ation note – I	learable feat	ure set		
0x55	INT_LAT CH	0x00				reserved				int_latch
0x54	INT2_IO _CTRL	0x00		reserved		input_en	output_e n	od	lvl	edge_ctrl
0x53	INT1_IO _CTRL	0x00		reserved		input_en	output_e n	od	lvl	edge_ctrl
0x52	-	-				rese	rved			
	-	-				rese	rved			
0x50	-	-				rese	rved			
0x4F	AUX_W R_DATA	0x02				write	_data			
0x4E	AUX W R ADDR	0x4C				write _.	_addr			
0x4D	AUX_RD ADDR	0x42		read_addr						
0x4C	AUX_IF_	0x83	aux_man			reserved			aux_rc	_burst
0x4B	CONF AUX_DE	0x20	ual_en		i2	c_device_ad	dr			reserved
0x4A	V_ID	-		_	_			_	_	
UX4A	FIFO_C	-				rese				
0x49	ONFIG_	0x10	reserved	fifo_acc_ en	fifo_aux_ en	fifo_head er_en	fifo_tag_i nt1_en	fifo_tag_i nt2_en	rese	rved
	<u>1</u>									
0x48	FIFO_C ONFIG_	0x02			rese	rved			fifo_time	fifo_stop
	<u>0</u>								_en	_on_full
0x47	FIFO_W TM_1	0x02		reserved			fifo_v	water_mark_	12_8	
0x46	FIFO W	0x00				fifo_water_	_mark_7_0			
0x45	FIFO_D OWNS	0x80	acc_fifo_	a	cc_fifo_dowr	ns		rese	erved	
0x44	AUX_CO	0x46	filt_data aux_offset aux_odr							
0x43	<u>NF</u> -									
0x43	-	<u> </u>	reserved reserved							
0x41	ACC_RA NGE	0x01	reserved acc_range			ange				
0x40	ACC_CO	0xA8	acc_perf		acc_bwp			acc	_odr	
	<u>NF</u>		_mode							

025						***************************************		
0x3F	-	-				reserved reserved		
0x2B	-	-				reserved		
UXZD	INTERN				axes_re	reserved		
0x2A	AL_STAT	0x00	odr_high	odr_50hz	map_err	message		
UNZA	US US	0,00	_error	_error _error or				
0x29	-	-			<u> </u>	reserved		
0x28	-	-				reserved		
					Applica	ation note – Wearable feature set		
0x27	ACTIVIT	0x00				or		
	Y_TYPE				Applica	ation note – Hearable feature set		
0.26	FIFO_DA	0,00				file date		
0x26	<u>TA</u>	0x00				fifo_data		
0x25	FIFO_LE	0x00	rese	erved		fifo_byte_counter_13_8		
0,20	NGTH_1	0,00	1030			ino_byte_counter_10_0		
0x24	FIFO_LE	0x00				fifo_byte_counter_7_0		
	NGTH_0							
0x23	-	-				reserved		
0x22	TEMPER	0x00				temperature		
	ATURE				Annline	tion note. Moorable feature act		
0x21	STEP_C OUNTER	0x00			Applica	tion note – Wearable feature set		
0,21	<u>3</u>	0.000			Δnnlica	ation note – Hearable feature set		
	STEP_C					tion note – Wearable feature set		
0x20	OUNTER	0x00			7 (6)	or		
	2				Applica	ation note - Hearable feature set		
	STEP_C				Applica	tion note – Wearable feature set		
0x1F	OUNTER	0x00				or		
	_1				Applica	ation note - Hearable feature set		
	STEP_C				Applica	tion note – Wearable feature set		
0x1E	<u>OUNTER</u>	0x00				or		
	_0					ation note - Hearable feature set		
0x1D	INT_STA	0x00	acc_drdy	reserved	aux_drdy	reserved	fwm_int	ffull_int
	TUS_1		_int		_int		_	_
	INT_STA				Applica	ation note – Wearable feature set		
0x1C	<u>TUS_0</u>	0x00			Amplia	or ation note – Hearable feature set		
					Applica	ation note – Hearable leature set		por_dete
0x1B	<u>EVENT</u>	0x01				reserved		cted
	SENSOR							cteu
0x1A	TIME_2	0x00				sensor_time_23_16		
	SENSOR							
0x19	TIME_1	0x00	sensor_time_15_8					
0.40	SENSOR	0.00						
0x18	TIME_0	0x00	sensor_time_7_0					
0x17	<u>DATA_13</u>	0x00	acc_z_15_8					
0x16	<u>DATA_12</u>	0x00	acc_z_7_0					
0x15	DATA_11	0x00		acc_y_15_8				
0x14	DATA_10	0x00				acc_y_7_0		
0x13	DATA_9	0x00				acc_x_15_8		

0x12	DATA 8	0x00				acc_>	x_7_0			
0x11	DATA_7	0x00	aux_r_15_8							
0x10	DATA_6	0x00				aux_i	r_7_0			
0x0F	DATA_5	0x00				aux_z	_15_8			
0x0E	DATA_4	0x00				aux_z	z_7_0			
0x0D	DATA_3	0x00				aux_y	_15_8			
0x0C	DATA_2	0x00				aux_y	y_7_0			
0x0B	DATA_1	0x00				aux_x	_15_8			
0x0A	DATA_0	0x00				aux_x	x_7_0			
0x09	-	=				rese	rved			
•••	-	-				rese	rved			
0x04	-	-				rese	rved			
0x03	<u>STATUS</u>	0x10	drdy_acc	reserved	drdy_aux	cmd_rdy	reserved	aux_man _op	rese	rved
0x02	ERR_RE G	0x00	aux_err fifo_err reserved error_code cmd_err fatal_err							
0x01	-	i	reserved							
0x00	CHIP_ID	0x16				chip	o_id			

FEATURES_IN → Please check "Application note – Wearable feature set" or "Application note – Hearable feature set"

Register (0x00) CHIP_ID

DESCRIPTION: Chip identification code

RESET: 0x16

DEFINITION (Go to register map):

Name	Register (0x00) CHIP_ID				
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	1	
Content		chip	o_id		
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	1	1	0	
Content	chip_id				

chip_id: Chip identification code for BMA456.

Register (0x02) ERR_REG

DESCRIPTION: Reports sensor error conditions

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x02) ERR_REG				
Bit	7	6	5	4	
Read/Write	R	R	n/a	R	
Reset Value	0	0	0	0	
Content	aux_err	fifo_err	reserved	error_code	
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content	error	_code	cmd_err	fatal_err	

fatal_err: Fatal Error, chip is not in operational state (Boot-, power-system). This flag will be

reset only by power-on-reset or softreset.

cmd_err: Command execution failed. error_code: Error codes for persistent errors

error_code		
0x00	no_error	no error is reported
0x01	acc_err	error in Register ACC_CONF

fifo_err: Error in FIFO detected: Input data was discarded in stream mode. This flag will be

reset when read.

aux_err: Error in I2C-Master detected. This flag will be reset when read.

Register (0x03) STATUS

DESCRIPTION: Sensor status flags

RESET: 0x10

DEFINITION (Go to register map):

Name	Register (0x03) STA	Register (0x03) STATUS				
Bit	7	6	5	4		
Read/Write	R	n/a	R	R		
Reset Value	0	0	0	1		
Content	drdy_acc	reserved	drdy_aux	cmd_rdy		
Bit	3	2	1	0		
Read/Write	n/a	R	n/a	n/a		
Reset Value	0	0	0	0		
Content	reserved	aux_man_op	rese	erved		

aux_man_op: '1'('0') indicate a (no) manual auxiliary interface operation is ongoing.

cmd_rdy: CMD decoder status. `0' -> Command in progress `1' -> Command decoder is ready

to accept a new command

drdy_aux: Data ready for auxiliary sensor. It gets reset when one auxiliary DATA register is read

out

drdy_acc: Data ready for accelerometer. It gets reset when one accelerometer DATA register is

read out

Register (0x0A) DATA_0

DESCRIPTION: AUX_X(LSB)

RESET: 0x00

Name	Register (0x0A) DATA_0				
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content	aux_x_7_0				
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content	aux_x_7_0				

Register (0x0B) DATA_1

DESCRIPTION: AUX_X(MSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x0B) DATA_1				
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content		aux_x	_15_8		
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content	aux_x_15_8				

Register (0x0C) DATA_2

DESCRIPTION: AUX_Y(LSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x0C) DATA_2				
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content		aux_y_7_0			
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content	aux_y_7_0				

Register (0x0D) DATA_3

DESCRIPTION: AUX_Y(MSB)

RESET: 0x00

Name	Register (C	Register (0x0D) DATA_3			
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content			aux_y_15_8		
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content			aux_y_15_8		

Register (0x0E) DATA_4

DESCRIPTION: AUX_Z(LSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x0E) DATA_4				
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content		aux_z_7_0			
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content		aux_z	z_7_0		

Register (0x0F) DATA_5

DESCRIPTION: AUX_Z(MSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x0F) DATA_5			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	aux_z_15_8			
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		aux_z	_15_8	

Register (0x10) DATA_6

DESCRIPTION: AUX_R(LSB)

RESET: 0x00

Name	Register (0	Register (0x10) DATA_6			
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content			aux_r_7_0		
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content		aux_r_7_0			

Register (0x11) DATA_7

DESCRIPTION: AUX_R(MSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x11) DATA_7			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		aux_r_15_8		
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		aux_r	_15_8	

Register (0x12) DATA_8

DESCRIPTION: ACC_X(LSB)

RESET: 0x00

Name	Register (0x12) DATA_8			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_>	<_7_0	
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_>	<_7_0	

Register (0x13) DATA_9

DESCRIPTION: ACC_X(MSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x13) DATA_9			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	acc_x_15_8			
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_x	_15_8	

Register (0x14) DATA_10

DESCRIPTION: ACC_Y(LSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x14) DATA_10			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_y	/_7_0	
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_y	/_7_0	

Register (0x15) DATA_11

DESCRIPTION: ACC_Y(MSB)

RESET: 0x00

Name	Register (C	Register (0x15) DATA_11			
Bit	7	6	5	4	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content			acc_y_15_8		
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content		acc_y_15_8			

Register (0x16) DATA_12

DESCRIPTION: ACC_Z(LSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x16) DATA_12			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_z	z_7_0	
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_z	z_7_0	

Register (0x17) DATA_13

DESCRIPTION: ACC_Z(MSB)

RESET: 0x00

Name	Register (0x17) DATA_13			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_z	_15_8	
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		acc_z	_15_8	

Register (0x18) SENSORTIME_0

DESCRIPTION: Sensor time <7:0>

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x18) SENSORTIME_0			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	sensor_time_7_0			
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		sensor_t	ime_7_0	

sensor_time_7_0: Sensor time <7:0> in units of 39.0625 us.

Register (0x19) SENSORTIME_1

DESCRIPTION: Sensor time <15:8>

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x19) SEI	Register (0x19) SENSORTIME_1		
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		sensor_time_15_8		
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		sensor_time_15_8		

sensor_time_15_8: Sensor time <15:8> in units of 10 ms.

Register (0x1A) SENSORTIME_2

DESCRIPTION: Sensor time <23:16>

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x1A) SENSORTIME_2			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	sensor_time_23_16			
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	sensor_time_23_16			

sensor_time_23_16: Sensor time <23:16> in units of 2.56 s.

Register (0x1B) EVENT

DESCRIPTION: Sensor status flags

RESET: 0x01

DEFINITION (Go to register map):

Name	Register (0x1	Register (0x1B) EVENT		
Bit	7	6	5	4
Read/Write	n/a	n/a	n/a	n/a
Reset Value	0	0	0	0
Content		reserved		
Bit	3	2	1	0
Read/Write	n/a	n/a	n/a	R
Reset Value	0	0	0	1
Content		reserved por_detected		

por_detected: '1' after device power up or softreset. Clear-on-read

Register (0x1C) INT_STATUS_0

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x1D) INT_STATUS_1

DESCRIPTION: Interrupt Status. Will be cleared on read.

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x1D) INT_STATUS_1			
Bit	7	6	5	4
Read/Write	R	n/a	R	n/a
Reset Value	0	0	0	0
Content	acc_drdy_int	reserved	aux_drdy_int	reserved
Bit	3	2	1	0
Read/Write	n/a	n/a	R	R
Reset Value	0	0	0	0
Content	rese	rved	fwm_int	ffull_int

ffull_int: FIFO Full Interrupt

fwm_int: FIFO Watermark Interrupt

aux_drdy_int: Auxiliary sensor data ready interruptacc_drdy_int: Accelerometer data ready interrupt

Register (0x1E) STEP_COUNTER_0

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x1F) STEP_COUNTER_1

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x20) STEP_COUNTER_2

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x21) STEP_COUNTER_3

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x22) TEMPERATURE

DESCRIPTION: Contains the temperature value of the sensor

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x22) TE	Register (0x22) TEMPERATURE		
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		temperature		
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		temperature		

temperature: Temperature value in two's complement representation in units of 1 Kelvin: 0x00 corresponds to 23 degree Celsius.

Register (0x24) FIFO_LENGTH_0

DESCRIPTION: FIFO byte count register (LSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0	Register (0x24) FIFO_LENGTH_0		
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		fifo_byte_counter_7_0		
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content		fifo_byte_counter_7_0		

fifo_byte_counter_7_0: Current fill level of FIFO buffer (unit: byte).

Register (0x25) FIFO_LENGTH_1

DESCRIPTION: FIFO byte count register (MSB)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x25) FIF	Register (0x25) FIFO_LENGTH_1			
Bit	7	6	5	4	
Read/Write	n/a	n/a	R	R	
Reset Value	0	0	0	0	
Content	rese	reserved		fifo_byte_counter_13_8	
Bit	3	2	1	0	
Read/Write	R	R	R	R	
Reset Value	0	0	0	0	
Content	fifo_byte_counter_13_8				

fifo_byte_counter_13_8:

FIFO byte counter bits 13..8.

Register (0x26) FIFO_DATA

DESCRIPTION: FIFO data output register

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x26) FIFO_DATA			
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	fifo_data			
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	fifo_data			

fifo_data: FIFO read data, for burst read.

Register (0x27) ACTIVITY_TYPE

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x2A) INTERNAL_STATUS

DESCRIPTION: Error bits and message indicating internal status

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x2A) IN	Register (0x2A) INTERNAL_STATUS		
Bit	7	6	5	4
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	odr_high_error	odr_50hz_error	axes_remap_error	message
Bit	3	2	1	0
Read/Write	R	R	R	R
Reset Value	0	0	0	0
Content	message			

message: Internal Status Message

message		
0x00	not_init	ASIC is not initialized
0x01	init_ok	ASIC initialized
0x02	init_err	Initialization error
0x03	drv_err	Invalid driver
0x04	sns_stop	Sensor stopped

axes_remap_error: Axes remapped wrongly because a source axis is not assigned to more than

one target axis.

odr_50hz_error: The minimum bandwidth conditions are not respected for the features which

require 50 Hz data.

odr_high_error: The minimum bandwidth conditions are not respected for the single/double tap

Detection.

Register (0x40) ACC_CONF

DESCRIPTION: Sets the output data rate, the bandwidth, and the performance mode of the

acceleration sensor

RESET: 0xA8

DEFINITION (Go to register map):

Name	Register (0x40) ACC_CONF			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	1	0	1	0
Content	acc_perf_mode	acc_bwp		
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	1	0	0	0
Content	acc_odr			

acc_odr: ODR in Hz. The output data rate is independent of the power mode setting for the sensor, but not all settings are supported in all power modes.

acc_odr		
0x00	reserved	Reserved
0x01	odr_0p78	25/32
0x02	odr_1p5	25/16
0x03	odr_3p1	25/8
0x04	odr_6p25	25/4
0x05	odr_12p5	25/2
0x06	odr_25	25
0x07	odr_50	50
0x08	odr_100	100
0x09	odr_200	200
0x0a	odr_400	400
0x0b	odr_800	800
0x0c	odr_1k6	1600
0x0d	odr_3k2	Reserved
0x0e	odr_6k4	Reserved
0x0f	odr_12k8	Reserved

acc_bwp: Bandwidth parameter, determines filter configuration (acc_perf_mode=1) and averaging for undersampling mode (acc_perf_mode=0)

acc_bwp		
0x00	osr4_avg1	acc_perf_mode = 1 -> OSR4 mode; acc_perf_mode = 0 -> no averaging
0x01	osr2_avg2	<pre>acc_perf_mode = 1 -> OSR2 mode; acc_perf_mode = 0 -> average 2 samples</pre>
0x02	norm_avg4	<pre>acc_perf_mode = 1 -> normal mode; acc_perf_mode = 0 -> average 4 samples</pre>
0x03	cic_avg8	<pre>acc_perf_mode = 1 -> Reserved; acc_perf_mode = 0 -> average 8 samples</pre>
0x04	res_avg16	<pre>acc_perf_mode = 1 -> Reserved; acc_perf_mode = 0 -> average 16 samples</pre>
0x05	res_avg32	<pre>acc_perf_mode = 1 -> Reserved; acc_perf_mode = 0 -> average 32 samples</pre>
0x06	res_avg64	<pre>acc_perf_mode = 1 -> Reserved; acc_perf_mode = 0 -> average 64 samples</pre>
0x07	res_avg128	acc_perf_mode = 1 -> Reserved; acc_perf_mode = 0 -> average 128 samples

acc_perf_mode: Select accelerometer filter performance mode:

acc_perf_mode		
0x00	cic_avg	averaging mode.
0x01	cont	continuous filter function.

Register (0x41) ACC_RANGE

DESCRIPTION: Selection of the Accelerometer g-range

RESET: 0x01

Name	Register (0x41) A	Register (0x41) ACC_RANGE			
Bit	7	6	5	4	
Read/Write	n/a	n/a	n/a	n/a	
Reset Value	0	0	0	0	
Content		reserved			
Bit	3	2	1	0	
Read/Write	n/a	n/a	RW	RW	
Reset Value	0	0	0	1	
Content	re	reserved		acc_range	

acc_range: Accelerometer g-range

acc_range		
0x00	range_2g	+/-2g
0x01	range_4g	+/-4g
0x02	range_8g	+/-8g
0x03	range_16g	+/-16g

Register (0x44) AUX_CONF

DESCRIPTION: Sets the output data rate of the Auxiliary interface

RESET: 0x46

DEFINITION (Go to register map):

Name	Register (0x44) AUX_CONF			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	0	1	0	0
Content	aux_offset			
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	1	1	0
Content	aux_odr			

aux_odr: Select the poll rate for the sensor attached to the Auxiliary interface.

aux_odr		
0x00	reserved	Reserved
0x01	odr_0p78	25/32
0x02	odr_1p5	25/16
0x03	odr_3p1	25/8
0x04	odr_6p25	25/4
0x05	odr_12p5	25/2
0x06	odr_25	25
0x07	odr_50	50
0x08	odr_100	100
0x09	odr_200	200
0x0a	odr_400	400
0x0b	odr_800	800
0x0c	odr_1k6	Reserved
0x0d	odr_3k2	Reserved
0x0e	odr_6k4	Reserved
0x0f	odr_12k8	Reserved

aux_offset: trigger-readout offset in units of 2.5 ms. If set to zero, the offset is maximum, i.e. after readout a trigger is issued immediately.

Register (0x45) FIFO_DOWNS

DESCRIPTION: Configure Accelerometer downsampling rates for FIFO

RESET: 0x80

DEFINITION (Go to register map):

Name	Register (0x45) FIFO_DOWNS			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	1	0	0	0
Content	acc_fifo_filt_data		acc_fifo_downs	
Bit	3	2	1	0
Read/Write	n/a	n/a	n/a	n/a
Reset Value	0	0	0	0
Content	reserved			

acc_fifo_downs: Downsampling for accelerometer data (by 2**acc_fifo_downs) acc_fifo_filt_data: selects filtered or unfiltered Accelerometer data for FIFO

acc_fifo_filt_data		
0x00	unfiltered	Unfiltered data
0x01	filtered	Filtered data

Register (0x46) FIFO_WTM_0

DESCRIPTION: FIFO Watermark level LSB (unit: byte)

RESET: 0x00

Name	Register (0x46) FIFO_WTM_0			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content		fifo_water_mark_7_0		
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content	fifo_water_mark_7_0			

Register (0x47) FIFO_WTM_1

DESCRIPTION: FIFO Watermark level MSB

RESET: 0x02

DEFINITION (Go to register map):

Name	Register (0x47) FIFO_WTM_1			
Bit	7	6	5	4
Read/Write	n/a	n/a	n/a	RW
Reset Value	0 0 0			
Content				fifo_water_mark_1 2_8
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	1	0
Content	fifo_water_mark_12_8			

Register (0x48) FIFO_CONFIG_0

DESCRIPTION: FIFO frame content configuration

RESET: 0x02

DEFINITION (Go to register map):

Name	Register (0x48) FIFO_CONFIG_0			
Bit	7	6	5	4
Read/Write	n/a	n/a	n/a	n/a
Reset Value	0	0	0	0
Content	reserved			
Bit	3	2	1	0
Read/Write	n/a	n/a	RW	RW
Reset Value	0	0	1	0
Content	reserved		fifo_time_en	fifo_stop_on_full

fifo_stop_on_full: Stop writing samples into FIFO when FIFO is full.

fifo_stop_on_full		
0x00	disable	do not stop writing to FIFO when full
0x01	enable	Stop writing into FIFO when full.

fifo_time_en: Return sensortime frame after the last valid data frame.

fifo_time_en		
0x00	disable	do not return sensortime frame
0x01	enable	return sensortime frame

Register (0x49) FIFO_CONFIG_1

DESCRIPTION: FIFO frame content configuration

RESET: 0x10

DEFINITION (Go to register map):

Name	Register (0x49) FIF	Register (0x49) FIFO_CONFIG_1			
Bit	7	6	5	4	
Read/Write	n/a	RW	RW	RW	
Reset Value	0	0	0	1	
Content	reserved	fifo_acc_en	fifo_aux_en	fifo_header_en	
Bit	3	2	1	0	
Read/Write	RW	RW	n/a	n/a	
Reset Value	0	0	0	0	
Content	fifo_tag_int1_en	fifo_tag_int2_en	rese	erved	

fifo_tag_int2_en: FIFO interrupt 2 tag enable

fifo_tag_int2_en		
0x00	disable	disable tag
0x01	enable	enable tag

fifo_tag_int1_en: FIFO interrupt 1 tag enable

fifo_tag_int1_en		
0x00	disable	disable tag
0x01	enable	enable tag

fifo_header_en: FIFO frame header enable

fifo_header_en		
0x00	disable	no header is stored (output data rate of all enabled sensors need to be identical)
0x01	enable	header is stored

fifo_aux_en: Store Auxiliary data in FIFO (all 3 axes)

fifo_aux_en		
0x00	disable	no Auxiliary data is stored
0x01	enable	Auxiliary data is stored

fifo_acc_en: Store Accelerometer data in FIFO (all 3 axes)

fifo_acc_en		
0x00	disable	no Accelerometer data is stored
0x01	enable	Accelerometer data is stored

Register (0x4B) AUX_DEV_ID

DESCRIPTION: Auxiliary interface slave device address

RESET: 0x20

DEFINITION (Go to register map):

Name	Register (0x4	Register (0x4B) AUX_DEV_ID			
Bit	7	6	5	4	
Read/Write	RW	RW	RW	RW	
Reset Value	0	0	1	0	
Content	i2c_device_a	i2c_device_addr			
Bit	3	2	1	0	
Read/Write	RW	RW	RW	n/a	
Reset Value	0	0	0	0	
Content		i2c_device_addr			

i2c_device_addr: I2C device address of Auxiliary slave

Register (0x4C) AUX_IF_CONF

DESCRIPTION: Auxiliary interface configuration

RESET: 0x83

DEFINITION (Go to register map):

Name	Register (0x4C) AUX_IF_CONF			
Bit	7	6	5	4
Read/Write	RW	n/a	n/a	n/a
Reset Value	1	0	0	0
Content	aux_manual_en	reserved		
Bit	3	2	1	0
Read/Write	n/a	n/a	RW	RW
Reset Value	0	0	1	1
Content	reserved aux_rd_burst			

aux_rd_burst: Burst data length (1,2,6,8 byte)

aux_rd_burst		
0x00	BL1	Burst length 1
0x01	BL2	Burst length 2
0x02	BL6	Burst length 6
0x03	BL8	Burst length 8

aux_manual_en: Enable auxiliary interface manual mode.

aux_manual_en		
0x00	disable	Data mode
0x01	enable	Setup mode

Register (0x4D) AUX_RD_ADDR

DESCRIPTION: Auxiliary interface read register address

RESET: 0x42

DEFINITION (Go to register map):

Name	Register (0x4D) AUX_RD_ADDR			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	0	1	0	0
Content		read_addr		
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	1	0
Content		read_addr		

read_addr: Address to read

Register (0x4E) AUX_WR_ADDR

DESCRIPTION: Auxiliary interface write register address

RESET: 0x4C

DEFINITION (Go to register map):

Name	Register (0x4E) AUX_WR_ADDR			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	0	1	0	0
Content	write_addr			
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	1	1	0	0
Content	write_addr			

write_addr: Address to write

Register (0x4F) AUX_WR_DATA

DESCRIPTION: Auxiliary interface write data

RESET: 0x02

DEFINITION (Go to register map):

Name	Register (0x4F) AUX_WR_DATA				
Bit	7	7 6 5 4			
Read/Write	RW	RW	RW	RW	
Reset Value	0	0	0	0	
Content		write_data			
Bit	3	2	1	0	
Read/Write	RW	RW	RW	RW	
Reset Value	0	0	1	0	
Content	write_data				

write_data: Data to write

Register (0x53) INT1_IO_CTRL

DESCRIPTION: Configure the electrical behavior of the interrupt pins

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x53) INT1_IO_CTRL			
Bit	7	6	5	4
Read/Write	n/a	n/a	n/a	RW
Reset Value	0	0	0	0
Content	reserved			input_en
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content	output_en	od	lvl	edge_ctrl

edge_ctrl: Configure trigger condition of INT1 pin (input)

edge_ctrl		
0x00	level_tr	Level
0x01	edge tr	Edge

Ivl: Configure output level of INT1 pin

lvl		
0x00	active_low	active low
0x01	active_high	active high

od: Configure output behavior of INT1 pin to open drain.

od		
0x00	push_pull	push-pull
0x01	open_drain	open drain

output_en: Output enable for INT1 pin

output_en		
0x00	off	Output disabled
0x01	on	Output enabled

input_en: Input enable for INT1 pin

input_en		
0x00	off	Input disabled
0x01	on	Input enabled

Register (0x54) INT2_IO_CTRL

DESCRIPTION: Configure the electrical behavior of the interrupt pins

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x54)	Register (0x54) INT2_IO_CTRL			
Bit	7	7 6 5			
Read/Write	n/a	n/a	n/a	RW	
Reset Value	0	0	0	0	
Content		reserve	ed	input_en	
Bit	3	2	1	0	
Read/Write	RW	RW	RW	RW	
Reset Value	0	0	0	0	
Content	output_en	od	lvl	edge_ctrl	

edge_ctrl: Configure trigger condition of INT2 pin (input)

edge_ctrl		
0x00	level_tr	Level
0x01	edge_tr	Edge

Ivl: Configure output level of INT2 pin

lvl		
0x00	active_low	active low
0x01	active_high	active high

od: Configure output behavior of INT2 pin to open drain.

od		
0x00	push_pull	push-pull
0x01	open_drain	open drain

output_en: Output enable for INT2 pin

output_en		
0x00	off	Output disabled
0x01	on	Output enabled

input_en: Input enable for INT2 pin

input_en		
0x00	off	Input disabled
0x01	on	Input enabled

Register (0x55) INT_LATCH

DESCRIPTION: Configure interrupt latch modes

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x55) IN	Register (0x55) INT_LATCH				
Bit	7	6	5	4		
Read/Write	n/a	n/a	n/a	n/a		
Reset Value	0	0	0	0		
Content	reserved	reserved				
Bit	3	2	1	0		
Read/Write	n/a	n/a	n/a	RW		
Reset Value	0	0	0	0		
Content		reserved				

int_latch: Latched/non-latched interrupt modes

int_latch		
0x00	none	non latched
0x01	permanent	latched

Register (0x56) INT1_MAP

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x57) INT2_MAP

DESCRIPTION: Please check "Application note - Wearable feature set" or "Application note -

Hearable feature set"

RESET: 0x00

Register (0x58) INT_MAP_DATA

DESCRIPTION: Map interrupt sources to hardware interrupts

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x58)	Register (0x58) INT_MAP_DATA				
Bit	7	6	5	4		
Read/Write	n/a	RW	RW	RW		
Reset Value	0	0	0	0		
Content	reserved	int2_drdy	int2_fwm	int2_ffull		
Bit	3	2	1	0		
Read/Write	n/a	RW	RW	RW		
Reset Value	0	0	0	0		
Content	reserved	int1_drdy	int1_fwm	int1_ffull		

int1_ffull: FIFO Full interrupt mapped to INT1

int1_fwm: FIFO Watermark interrupt mapped to INT1 int1_drdy: Data Ready interrupt mapped to INT1 int2_ffull: FIFO Full interrupt mapped to INT2

int2_fwm: FIFO Watermark interrupt mapped to INT2 int2_drdy: Data Ready interrupt mapped to INT2

Register (0x59) INIT_CTRL

DESCRIPTION: Start initialization

RESET: 0x90

DEFINITION (Go to register map):

Name	Register (0x59) INIT_CTRL			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	1	0	0	1
Content	init_ctrl			
Bit	3	2	1	0
Read/Write	RW RW RW			
Reset Value	0	0	0	0
Content	init_ctrl			

init_ctrl: Commands to start initialization

init_ctrl		
0x00	Load configuration file	Enable the mode for accept configuration file
0x01	Start initialization	Enable sensor features after loading configuration file

Note: the commands should not been used more than once after POR or softreset, and the process of start initialization described in chapter 4.2 should be strictly followed.

Register (0x5E) FEATURES_IN

DESCRIPTION: Feature configuration read/write port → Please check "Application note – Wearable feature set" or "Application note – Hearable feature set"

RESET: 0x00

Name	Register (0)	Register (0x5E) FEATURES_IN				
Bit	7	7 6 5 4				
Read/Write	RW	RW	RW	RW		
Reset Value	0	0	0	0		
Content			features_in			
Bit	3	2	1	0		
Read/Write	RW	RW RW RW				
Reset Value	0	0 0 0				
Content		features_in				

Register (0x5F) INTERNAL_ERROR

DESCRIPTION: Internal error flags

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x5	Register (0x5F) INTERNAL_ERROR				
Bit	7	7 6 5 4				
Read/Write	n/a	n/a	n/a	n/a		
Reset Value	0	0	0	0		
Content		reserved				
Bit	3	2	1	0		
Read/Write	n/a	n/a R R n/a				
Reset Value	0	0 0 0				
Content	reserved	int_err_2	int_err_1	reserved		

int_err_1: Internal error flag - long processing time, processing halted

int_err_2: Internal error flag - fatal error, processing halted

Register (0x6A) NVM_CONF

DESCRIPTION: NVM controller mode (Prog/Erase or Read only)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x6A) NV	Register (0x6A) NVM_CONF				
Bit	7	7 6 5 4				
Read/Write	n/a	n/a	n/a	n/a		
Reset Value	0	0	0	0		
Content		rese	rved			
Bit	3	2	1	0		
Read/Write	n/a	n/a	RW	n/a		
Reset Value	0	0	0	0		
Content	rese	reserved nvm prog en reserved				

nvm_prog_en: Enable NVM programming

nvm_prog_en		
0x00	disable	disable
0x01	enable	enable

Register (0x6B) IF_CONF

DESCRIPTION: Serial interface settings

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0)	Register (0x6B) IF_CONF				
Bit	7	7 6 5 4				
Read/Write	n/a	n/a	n/a	RW		
Reset Value	0	0	0	0		
Content		reserved				
Bit	3	2	1	0		
Read/Write	n/a	n/a	n/a	RW		
Reset Value	0	0	0	0		
Content	reserved	reserved				

spi3: Configure SPI Interface Mode for primary interface

spi3		
0x00	spi4	SPI 4-wire mode
0x01	spi3	SPI 3-wire mode

if_mode: Auxiliary interface configuration

if_mode		
0x00	p_auto_s_off	Auxiliary interface:off
0x01	p_auto_s_mag	Auxilary interface:Magnetometer

Register (0x6D) ACC_SELF_TEST

DESCRIPTION: Settings for the sensor self-test configuration and trigger

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x6D) AC	Register (0x6D) ACC_SELF_TEST			
Bit	7	6	5	4	
Read/Write	n/a	n/a	n/a	n/a	
Reset Value	0	0	0	0	
Content		reserved			
Bit	3	2	1	0	
Read/Write	RW	RW	n/a	RW	
Reset Value	0	0	0	0	
Content	acc_self_test_amp	acc_self_test_sign	reserved	acc_self_test_en	

acc_self_test_en: Enable accelerometer self-test

acc_self_test_en		
0x00	disabled	disabled
0x01	enabled	enabled

acc_self_test_sign: select sign of self-test excitation as

acc_self_test_sign		
0x00	negative	negative
0x01	positive	positive

acc_self_test_amp: select amplitude of the selftest deflection:

acc_self_test_amp		
0x00	low	low
0x01	high	high

Register (0x70) NV_CONF

DESCRIPTION: NVM backed configuration bits (check chapter **Error! Reference source not found.** for details).

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x70) NV	Register (0x70) NV_CONF		
Bit	7	6	5	4
Read/Write	n/a	n/a	n/a	n/a
Reset Value	0	0	0	0
Content		reserved		
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content	acc_off_en	i2c_wdt_en	i2c_wdt_sel	spi_en

spi_en: disable the I2C and enable SPI for the primary interface, when it is in autoconfig mode (check chapter **Error! Reference source not found.** for details).

spi_en		
0x00	disabled	I2C enabled
0x01	enabled	I2C disabled

i2c_wdt_sel: Select timer period for I2C Watchdog

i2c_wdt_sel		
0x00	wdt_short	I2C watchdog timeout after 1.25 ms
0x01	wdt_long	I2C watchdog timeout after 40 ms

i2c_wdt_en: I2C Watchdog at the SDA pin in I2C interface mode

i2c_wdt_en		
0x00	Disable	Disable I2C watchdog
0x01	Enable	Enable I2C watchdog

acc_off_en: Add the offset defined in the off_acc_x/y/z OFFSET register to filtered and unfiltered Accelerometer data

acc_off_en		
0x00	disabled	Disabled
0x01	enabled	Enabled

Register (0x71) OFFSET_0

DESCRIPTION: Offset compensation for Accelerometer X-axis (NVM backed)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x71) OFFSET_0			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content		off_acc_x		
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content	off_acc_x			

off_acc_x: Accelerometer offset compensation (X-axis).

Register (0x72) OFFSET_1

DESCRIPTION: Offset compensation for Accelerometer Y-axis (NVM backed)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x72)	Register (0x72) OFFSET_1		
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content		off_acc_y		
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content		off_acc_y		

off_acc_y: Accelerometer offset compensation (Y-axis).

Register (0x73) OFFSET_2

DESCRIPTION: Offset compensation for Accelerometer Z-axis (NVM backed)

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x73) OFFSET_2			
Bit	7	6	5	4
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content		off_acc_z		
Bit	3	2	1	0
Read/Write	RW	RW	RW	RW
Reset Value	0	0	0	0
Content	off_acc_z			

off_acc_z: Accelerometer offset compensation (Z-axis).

Register (0x7C) PWR_CONF

DESCRIPTION: Power mode configuration register

RESET: 0x03

DEFINITION (Go to register map):

Name	Register (0x7C) PWR_CONF			
Bit	7	6	5	4
Read/Write	n/a	n/a	n/a	n/a
Reset Value	0	0	0	0
Content		reserved		
Bit	3	2	1	0
Read/Write	n/a	n/a	RW	RW
Reset Value	0	0	1	1
Content	rese	rved	fifo_self_wakeup	adv_power_save

adv_power_save		
0x00	aps_off	advanced power save disabled (fast clk always enabled).
0x01	aps_on	advanced power mode enabled (slow clk is active when no
		measurement is ongoing.)

fifo_self_wakeup		
0x00	fsw_off	FIFO read disabled in advanced power saving mode.
0x01	fsw_on	FIFO read enabled after interrupt in advanced power saving mode.

Register (0x7D) PWR_CTRL

DESCRIPTION: Sensor enable register

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0x7	Register (0x7D) PWR_CTRL										
Bit	7	6	5	4								
Read/Write	n/a	n/a	n/a	n/a								
Reset Value	0	0	0	0								
Content			reserved									
Bit	3	2	1	0								
Read/Write	n/a	RW	n/a	RW								
Reset Value	0	0	0	0								
Content	reserved	acc_en	reserved	aux_en								

aux_en		
0x00	mag_off	Disables the auxiliary sensor.
0x01	mag_on	Enables the auxiliary sensor.

acc_en		
0x00	acc_off	Disables the Accelerometer.
0x01	acc_on	Enables the Accelerometer.

Register (0x7E) CMD

DESCRIPTION: Command Register

RESET: 0x00

DEFINITION (Go to register map):

Name	Register (0:	Register (0x7E) CMD									
Bit	7	6	5	4							
Read/Write	RW	RW	RW	RW							
Reset Value	0	0	0	0							
Content			cmd								
Bit	3	2	1 0								
Read/Write	RW	RW	RW	RW							
Reset Value	0	0	0	0							
Content		cmd									

cmd: Available commands (Note: Register will always read as 0x00):

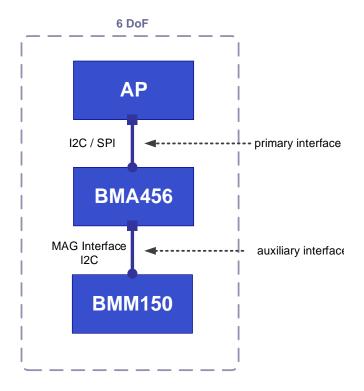
cmd		
0xa0	nvm_prog	Writes the NVM backed registers into NVM
0xb0	fifo_flush	Clears all data in the FIFO, does not change FIFO_CONFIG and FIFO_DOWNS registers
0xb6	softreset	Triggers a reset, all user configuration settings are overwritten with their default state

6. Digital Interfaces

6.1. Interfaces

Beside the standard primary interface (I2C and SPI configurable), where sensor acts as a slave to the application processor, BMA456 supports an auxiliary interface. See picture below.

If the auxiliary interface is enabled, the BMA456 can be connected to an external sensor (e.g. a magnetometer) in order to build a 6-DoF solution. Then the BMA456 will act as a master to the external sensor, reading the sensor data automatically and providing it to the application processor via the primary interface.



6.2. Primary Interface

By default, the BMA456 operates in I2C mode. The BMA456 interface can also be configured to operate in a SPI 4-wire configuration. It can also be re-configured by software to work in 3-wire mode instead of 4-wire mode.

All 3 possible digital interfaces share partly the same pins. The mapping for the primary interface of the BMA456 is given in the following table:

Pin#	Name	I/O Type	Description	Con	nect to (Prim	nary IF)
				in SPI4W	in SPI3W	in I2C
1	SDO	Digital I/O	Serial data output in SPI Address select in I ² C mode see chapter 7.2	SDO	DNC (float)	GND for default I2C addr.
2	SDX	Digital I/O	SDA serial data I/O in I ² C SDI serial data input in SPI 4W SDA serial data I/O in SPI 3W	SDI	SDA	SDA
5	INT1	Digital I/O	Interrupt output 1 (default) (Input for external FIFO sync) *	INT1 (FIFO sync)	INT1 (FIFO sync)	INT1 (FIFO sync)
6	INT2	Digital I/O	Interrupt output 2 (default) (Input for external FIFO sync) *	INT2 (FIFO sync)	INT2 (FIFO sync)	INT2 (FIFO sync)
10	CSB	Digital in	Chip select for SPI mode	CSB	CSB	V_{DDIO}
12	SCX	Digital in	SCK for SPI serial clock SCL for I ² C serial clock	SCK	SCK	SCL

^{*} INT1 and/or INT2 can also be configured as an input in case the external data synchronization in FIFO is used. See chapter 4.5. If INT1 and/or INT2 are not used, please do not connect them (DNC).

The following table shows the electrical specifications of the interface pins:

Parameter	Symbol	Condition	Min	Тур	Max	Units
Pull-up Resistance, CSB pin	Rup	Internal Pull-up Resistance to VDDIO	75	100	125	kΩ
Input Capacitance	Cin			5		pF
I ² C Bus Load Capacitance (max. drive capability)		V _{DDIO} >=1.62V			400	pF
C _{I2C_Load}	7)	V _{DDIO} <1.62V			120	pF

6.3. Primary Interface I2C/SPI Protocol Selection

The protocol is automatically selected based on the chip select CSB pin behavior after power-up.

At reset / power-up, BMA456 is in I2C mode. If CSB is connected to VDDIO during power-up and not changed, the sensor interface works in I2C mode. For using I2C, it is recommended to hard-wire the CSB line to VDDIO. Since power-on-reset is only executed when, both VDD and VDDIO are established, there is no risk of incorrect protocol detection due to power-up sequence.

If CSB sees a rising edge after power-up, the BMA456 interface switches to SPI until a reset or the next power-up occurs. Therefore, a CSB rising edge is needed before starting the SPI communication. Hence, it is recommended to perform a SPI single read of register CHIP ID (the obtained value will be invalid) before the actual communication start, in order to use the SPI interface.

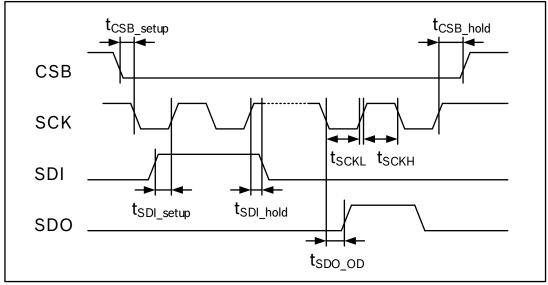
If toggling of the CSB bit is not possible without data communication, there is in addition the spi_en bit in Register NV CONF, which can be used to permanently set the primary interface to SPI without the need to toggle the CSB pin at every power-up or reset.

6.4. SPI interface and protocol

The timing specification for SPI of the BMA456 is given in the following table: SPI timing, valid at $V_{DDIO} \ge 1.71V$

Parameter	Symbol	Condition	Min	Max	Units
Clock Frequency	f _{SPI}	Max. Load on SDI or SDO = $30pF$, $V_{DDIO} \ge 1.62 \text{ V}$		10	MHz
		V _{DDIO} < 1.62V		7	MHz
SCK Low Pulse	t sckl	V _{DDIO} >=1.62V	45		ns
SCK High Pulse	t scкн	V _{DDIO} >=1.62V	45		ns
SCK Low Pulse	t sckl	V_{DDIO} <1.62 V	66		ns
SCK High Pulse	t scкн	V _{DDIO} <1.62V	66		ns
SDI Setup Time	t _{SDI_setup}		20		ns
SDI Hold Time	tsDI_hold		20		ns
SDO Output Delay	t _{SDO_OD}	Load = 30pF, V _{DDIO} ≥ 1.62V		30	ns
CSB Setup Time	t _{CSB_setup}		40		ns
CSB Hold Time	t _{CSB_hold}		40		ns
Idle time between write accesses, suspend mode, low-power mode 1	tIDLE_wacc_sum		450		μs
Idle time after write and read access, active state	tIDLE_wr_act		2		μs

The following figure shows the definition of the SPI timings:



SPI timing diagram

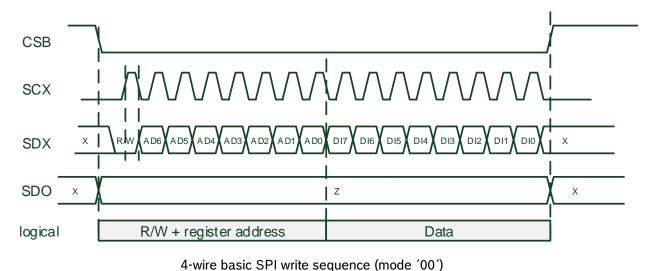
The SPI interface of the BMA456 is compatible with two modes, '00' [CPOL = '0' and CPHA = '0'] and '11' [CPOL = '1' and CPHA = '1']. The automatic selection between '00' and '11' is controlled based on the value of SCK after a falling edge of CSB.

Two configurations of the SPI interface are supported by the BMA456: 4-wire and 3-wire. The same protocol is used by both configurations. The device operates in 4-wire configuration by default. It can be switched to 3-wire configuration by writing IF-CONF.spi3 = 0b1. Pin SDI is used as the common data pin in 3-wire configuration.

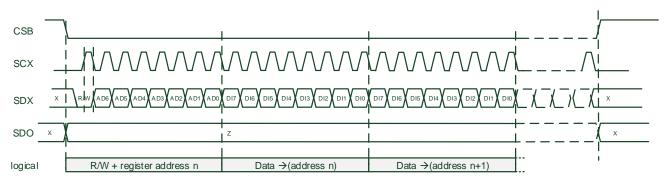
For single byte read as well as write operations, 16-bit protocols are used. The BMA456 also supports multiple-byte read and write operations.

In SPI 4-wire configuration CSB (chip select low active), SCK (serial clock), SDI (serial data input), and SDO (serial data output) pins are used. The communication starts when the CSB is pulled low by the SPI master and stops when CSB is pulled high. SCK is also controlled by SPI master. SDI and SDO are driven at the falling edge of SCK and should be captured at the rising edge of SCK.

The basic write operation waveform for 4-wire configuration is depicted in the following figure. During the entire write cycle SDO remains in high-impedance state.

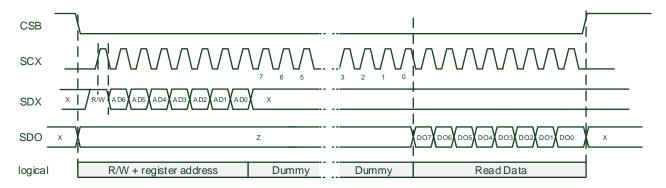


Multiple write operations are possible by keeping CSB low and continuing the data transfer. Only the first register address has to be written. Addresses are automatically incremented after each write access as long as CSB stays active low. The principle of multiple write is shown in figure below:



SPI multiple write

The basic read operation waveform for 4-wire configuration is depicted in the figure below. Please note that the first byte received from the BMA456 via the SDO line correspond to a dummy byte and the 2nd byte correspond to the value read out of the specified register address. That means, for a basic read operation two bytes have to be read and the first has to be dropped and the second byte must be interpreted.



4-wire basic SPI read sequence (mode '00')

The data bits are used as follows:

R/W: Read/Write bit. When 0, the data SDI is written into the chip. When 1, the data SDO from the chip is read.

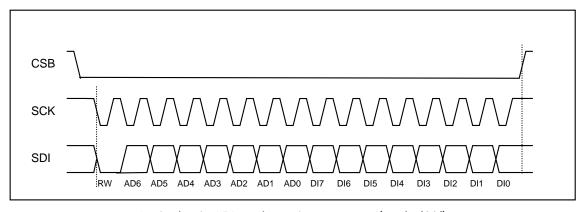
AD6-AD0: Address

DI7-DI0: When in write mode, these are the data SDI, which will be written into the address. DO7-DO0: When in read mode, these are the data SDO, which are read from the address.

Multiple read operations are possible by keeping CSB low and continuing the data transfer. Only the first register address has to be written. Addresses are automatically incremented after each read access as long as CSB stays active low. Please note that the first byte received from the BMA456 via the SDO line correspond to a dummy byte and the 2nd byte correspond to the value read out of the specified register address. The successive bytes read out correspond to values of incremented register addresses. That means, for a multiple read operation of n bytes, n+1 bytes have to be read, the first has to be dropped and the successive bytes must be interpreted.

In SPI 3-wire configuration CSB (chip select low active), SCK (serial clock), and SDI (serial data input and output) pins are used. While SCK is high, the communication starts when the CSB is pulled low by the SPI master and stops when CSB is pulled high. SCK is also controlled by SPI master. SDI is driven (when used as input of the device) at the falling edge of SCK and should be captured (when used as the output of the device) at the rising edge of SCK.

The protocol as such is the same in 3-wire configuration as it is in 4-wire configuration. The basic operation wave-form (read or write access) for 3-wire configuration is depicted in the figure below:



3-wire basic SPI read or write sequence (mode '11')

6.5. Primary I2C Interface

The I²C bus uses SCL (= SCx pin, serial clock) and SDA (= SDx pin, serial data input and output) signal lines. Both lines should connected to $V_{\rm DDIO}$ externally via pull-up resistors so that they are pulled high when the bus is free.

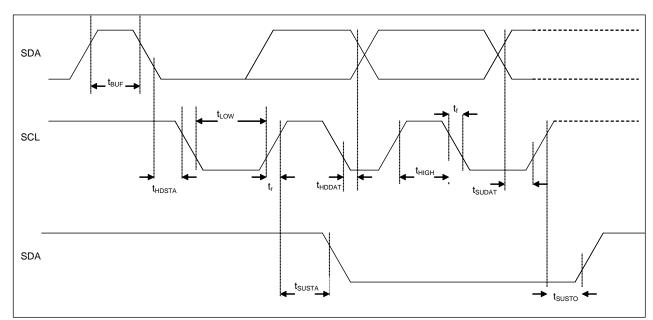
The default I²C address of the device is 0b0011000 (0x18). It is used if the SDO pin is pulled to 'GND'. The alternative address 0b0011001 (0x19) is selected by pulling the SDO pin to 'VDDIO'.

The I²C interface of the BMA456 is compatible with the I²C Specification UM10204 Rev. 03 (19 June 2007), available at http://www.nxp.com. The BMA456 supports I²C standard mode and fast mode, only 7-bit address mode is supported. For V_{DDIO} = 1.2V to 1.62 V the guaranteed voltage output levels are slightly relaxed as described in Table 1 of the electrical specification section.

BMA456 also supports an **extended I²C mode** that allows using clock frequencies up to 1 MHz. In this mode all timings of the fast mode apply and it additionally supports clock frequencies up to 1MHz.

The timing specification for I²C of the BMA456 is given in the following table:

Parameter	Symbol	Condition	Min	Max	Units
Clock Frequency	f _{SCL}			1000	kHz
SCL Low Period	tLOW		1.3		μs
SCL High Period	t HIGH		0.6		
SDA Setup Time	t sudat		0.1		
SDA Hold Time	t hddat		0.0		
Setup Time for a repeated Start Condition	t susta		0.6		
Hold Time for a Start Condition	t hdsta		0.6		
Setup Time for a Stop Condition	t susto		0.6		
Time before a new	t _{BUF}	low power mode	400		
Transmission can start		performence mode	2		
Idle time between write	tIDLE_wacc_nm	low power mode	450		
accesses, performence mode, low-power mode		performence mode	2		
Idle time between write accesses, suspend mode, low-power mode	t _{IDLE_wacc_sum}		450		



The figure below shows the definition of the I²C timings given in Table 28:

I2C timing diagram

The I2C protocol works as follows:

START: Data transmission on the bus begins with a high to low transition on the SDA line while SCL is held high (start condition (S) indicated by I²C bus master). Once the START signal is transferred by the master, the bus is considered busy.

STOP: Each data transfer should be terminated by a Stop signal (P) generated by master. The STOP condition is a low to high transition on SDA line while SCL is held high.

ACKS: Each byte of data transferred must be acknowledged. It is indicated by an acknowledge bit sent by the receiver. The transmitter must release the SDA line (no pull down) during the acknowledge pulse while the receiver must then pull the SDA line low so that it remains stable low during the high period of the acknowledge clock cycle.

In the following diagrams these abbreviations are used:

Start
Stop
Acknowle

ACKS Acknowledge by slave
ACKM Acknowledge by master
NACKM Not acknowledge by master

RW Read / Write

A START immediately followed by a STOP (without SCL toggling from 'VDDIO' to 'GND') is not supported. If such a combination occurs, the STOP is not recognized by the device.

I²C write access:

I²C write access can be used to write a data byte in one sequence.

The sequence begins with start condition generated by the master, followed by 7 bits slave address and a write bit (RW = 0). The slave sends an acknowledge bit (ACKS = 0) and releases the bus. Then the master sends the one byte register address. The slave again acknowledges the transmission and waits for the 8 bits of data which shall be written to the specified register address. After the slave acknowledges the data byte, the master generates a stop signal and terminates the writing protocol.

Example of an I2C write access:

Start			Slav	ve Ad	lress			R/W	ACK Register address (0x41)						ACK	CK Register data (0x01)						ACK	Stop					
S	0	0	1 	1	0	0	0	0	0	0	1	0	0	0	0	0	1	0	0	0	0	0	0	0	0	1	0	Р
			-> S > Ma																									

I²C write

Multi-byte writes are supported without restriction on normal registers with auto-increment, on special registers with address trap.

Start	Slave Adress				R/W	ACK	CK Register address (0x45)							ACK	Register data byte 0 (0x80) ACI				ACK								
S	0	0	1	1	0	0	0	0	0	0	1	0	0	0	1	0	1	0	1	0	0	0	0	0	0	0	0
	Reg	ister	data	byte	1 (0x6	64)		ACK									ACK		Reg	ister	data	byte i	า (0x)	XX)		ACK	Stop
0	1	1	0	0	1	0	0	0		 	 	- 	 - 	 	 		0	х	x 	х	х	х	x	×	x	0	Р
			-> S > Ma																								

I²C read access:

I²C read access also can be used to read one or multiple data bytes in one sequence.

A read sequence consists of a one-byte I²C write phase followed by the I²C read phase. The two parts of the transmission must be separated by a repeated start condition (S). The I²C write phase addresses the slave and sends the register address to be read. After slave acknowledges the transmission, the master generates again a start condition and sends the slave address together with a read bit (RW = 1). Then the master releases the bus and waits for the data bytes to be read out from slave. After each data byte the master has to generate an acknowledge bit (ACKS = 0) to enable further data transfer. A NACKM (after ACKS = 1) from the master stops the data being transferred from the slave. The slave releases the bus so that the master can generate a STOP condition and terminate the transmission.

The register address is automatically incremented and, therefore, more than one byte can be sequentially read out. Once a new data read transmission starts, the start address will be set to the register address specified since the latest I²C write command. By default the start address is set at 0x00. In this way repetitive multi-bytes reads from the same starting address are possible.

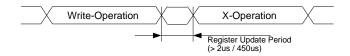
Start			Slav	ve I2	C ID			R/W	ACK		R	egist	er ad	dress	(0x1	2)		ACK										
S	0	0	1	1	0 	0	0	0	0	Х	0	0	1	0	0	1	0	0										
										Data byte									Data	byte)							
Repeat Start			Sla	ve I2	C ID	D R/W ACK Register data - address 0x12					ACK	K Register data - address 0x13						ACK										
Sr	0	0	1	1	0	0	0	1	0	Х	X	Х	X	X	X	Х	Х	0	Х	 X 	Х	I X I	X	X	X	X	0	
													Data	byte)				Data byte									
										Register data - address 0x14						ACK	Register data - address 0x15				ACK							
	Master -> Slave Slave -> Master					Х	X	Х	X	X	X	Х	X	0	Х	 X 	X	I X I	X	X	Х	X	0					
										Data byte Data byte																		
							Register data - address 0x16						ACK	Register data - address 0x17				NACK	Stop									

In order to prevent the I²C slave of the device to lock-up the I²C bus, a watchdog timer (WDT) is implemented. The WDT observes internal I²C signals and resets the I²C interface if the bus is locked-up by the BMA456. The activity and the timer period of the WDT can be configured through the bits NV_CONF.i2c_wdt_en and NV_CONF.i2c_wdt_sel.

6.6. SPI and I²C Access Restrictions

In order to allow for the correct internal synchronization of data written to the BMA456, certain access restrictions apply for consecutive write accesses or a write/read sequence through the SPI as well as I2C interface. The required waiting period depends on whether the device is operating in performence mode or other modes.

As illustrated in the figure below, an interface idle time of at least 2 μs is required following a write operation when the device operates in performance mode. In suspend mode and low power mode an interface idle time of at least 450 μs is required.



Post-Write Access Timing Constraints

6.7. Auxiliary Interface

The BMA456 allows attaching an external sensor (MAG-sensor) to a BMA456 via the auxiliary interface. The connection diagrams for the auxiliary interface are depicted in the chapter 7.3. The timings of the secondary I2C interface are the same as for the primary I2C interface, see chapter 6.5.

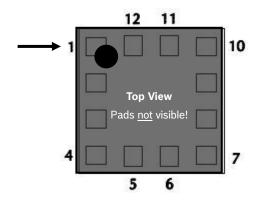
BM456 acts as a master of the secondary interface, controls the data acquisition of the MAG-sensor (slave of the secondary interface) and presents the data to the application processor (AP) in the user registers of the BMA456 through the primary interface. The internal pull-up resistors of ASCL and ASDA are by default disabled, so it is recommended to added pull-up resistors externally onto the secondary interface for proper I2C communication. Please contact your regional sales representative in case the internal pull-up resistors are necessary to be enabled. No additional I2C master or slave devices must be attached to the magnetometer interfaces.

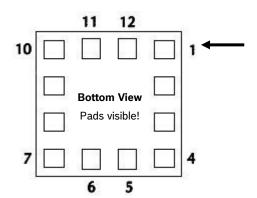
The BMA456 autonomously reads out the sensor data from BMM150 without intervention of the AP and stores the data in its data registers (per default) and FIFO (see Register FIFO CONFIG 1.fifo aux en). The initial setup of the BMM150 after power-on is done through indirect addressing in the BMA456. From a system perspective the initialization for BMM150 when attached to BMA456 should be possible within 100ms.

More information about the usage of Auxiliary Interface can be found in chapter 4.8.

7. Pin-out and Connection Diagrams

7.1. **Pin-out**





Pin description

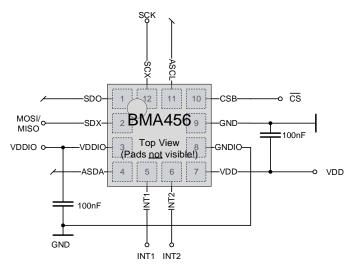
Pin#	Name	I/O Type	Description	Connect to							
				in SPI 4W	In SPI 3W	in I ² C					
1	SDO	Digital I/O	Serial data output in SPI Address select in I ² C mode see chapter 6.5	SDO	DNC (float)	GND for default I2C addr.					
2	SDX	Digital I/O	SDA serial data I/O in I ² C SDI serial data input in SPI 4W SDA serial data I/O in SPI 3W	SDI	SDA	SDA					
3	VDDIO	Supply	Digital I/O supply voltage (1.2V 3.6V)	V_{DDIO}	V_{DDIO}	V_{DDIO}					
4	ASDA	Digital I/O	Serial data I/O – Secondary Interface (I ² C Master for Magnetometer)	VDDIO/ GNDIO/NC or (ASDA - Secondary interface)	VDDIO/ GNDIO/NC or (ASDA - Secondary interface)	VDDIO/ GNDIO/NC or (ASDA - Secondary interface)					
5	INT1	Digital I/O	Interrupt output 1 (default) (Input for external FIFO sync) *	INT1 (FIFO sync)	INT1 (FIFO sync)	INT1 (FIFO sync)					
6	INT2	Digital I/O	Interrupt output 2 (default) (Input for external FIFO sync) *	INT2 (FIFO sync)	INT2 (FIFO sync)	INT2 (FIFO sync)					
7	VDD	Supply	Power supply for analog & digital domain (1.62V 3.6V)	V _{DD}	V_{DD}	V_{DD}					
8	GNDIO	Ground	Ground for I/O	GND	GND	GND					
9	GND	Ground	Ground for digital & analog	GND	GND	GND					
10	CSB	Digital in	Chip select for SPI mode	CSB	CSB	V_{DDIO}					
11	ASCL	Digital out	Digital clock (out) – Secondary Interface (I ² C Master for Magnetometer)	VDDIO/ GNDIO/NC or (ASCL - Secondary interface)	VDDIO/ GNDIO/ NC or (ASCL - Secondary interface)	VDDIO/ GNDIO/ NC or (ASCL - Secondary interface)					
12	SCX	Digital in	SCK for SPI serial clock SCL for I ² C serial clock	SCK	SCK	SCL					

^{*} INT1 and/or INT2 can also be configured as an input in case the external data synchronization in FIFO is used. See chapter 4.5. If INT1 and/or INT2 are not used, please do not connect them (DNC).

7.2. Connection Diagrams without Auxiliary Interface

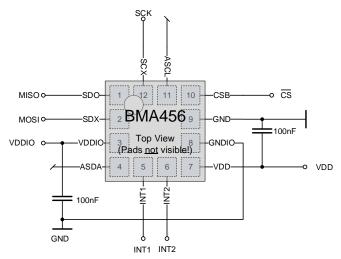
SPI

3-wire



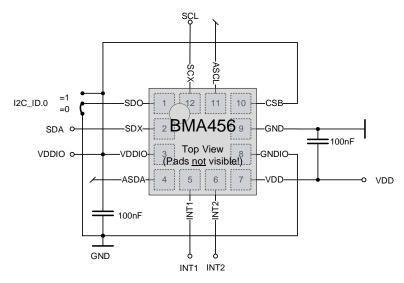
It is recommended to use 100nF decoupling capacitors at pin 3 (VDDIO) and pin 7 (VDD).

4-wire



It is recommended to use 100nF decoupling capacitors at pin 3 (VDDIO) and pin 7 (VDD).

I2C



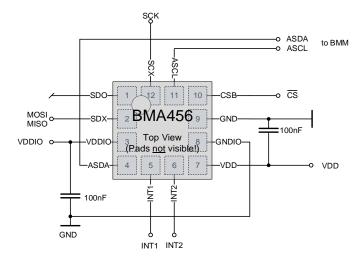
It is recommended to use 100nF decoupling capacitors at pin 3 (VDDIO) and pin 7 (VDD). SDA and SCL should be connected to V_{DDIO} externally via pull-up resistors so that they are pulled high when the bus is free.

7.3. Connection Diagrams with Auxiliary Interface

The internal pull-up resistors of ASCL and ASDA are by default disabled, so it is recommended to added pull-up resistors externally onto the secondary interface for proper I2C communication

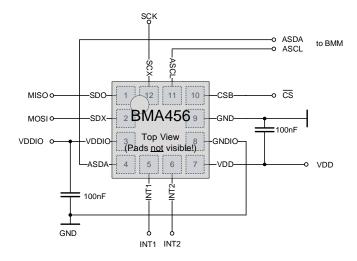
SPI

3-wire



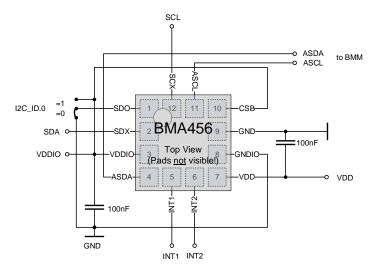
It is recommended to use 100nF decoupling capacitors at pin 3 (VDDIO) and pin 7 (VDD).

4-wire



It is recommended to use 100nF decoupling capacitors at pin 3 (VDDIO) and pin 7 (VDD).

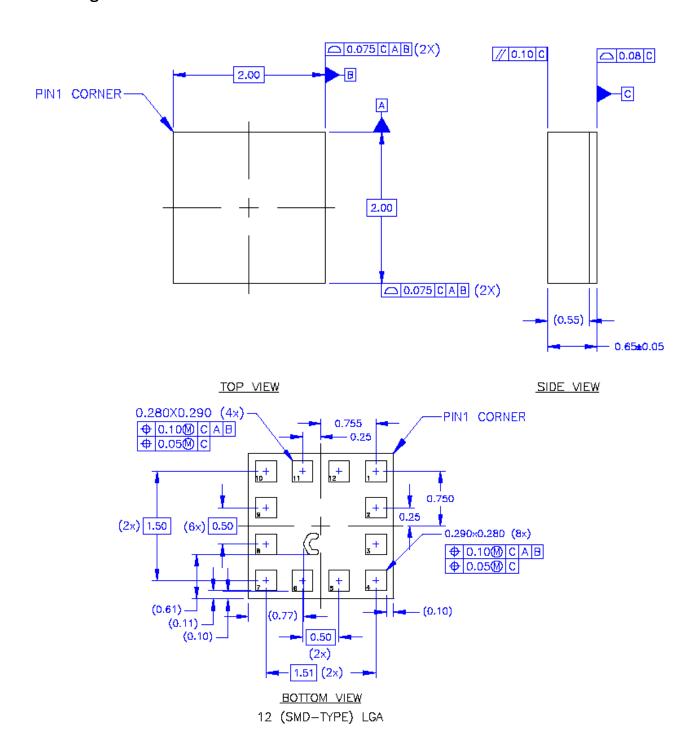
I2C



It is recommended to use 100nF decoupling capacitors at pin 3 (VDDIO) and pin 7 (VDD). SDA and SCL should be connected to V_{DDIO} externally via pull-up resistors so that they are pulled high when the bus is free.

8. Package

8.1. Package outline dimensions



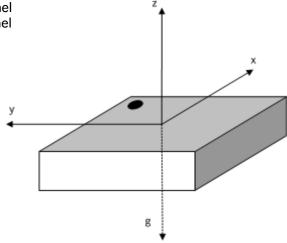
Note that the pin 5, 6, 11, 12 are in same direction (0.280*0.290, 4x), while pin 1, 2, 3, 4, 7, 8, 9, 10 are in same direction (0.290*0.280, 8x).

8.2. Sensing axis orientation

If the sensor is accelerated in the indicated directions, the corresponding channel will deliver a positive acceleration signal (dynamic acceleration). If the sensor is at rest and the force of gravity is acting along the indicated directions, the output of the corresponding channel will be negative (static acceleration).

Example: If the sensor is at rest or at uniform motion in a gravity field according to the figure given below, the output signals are:

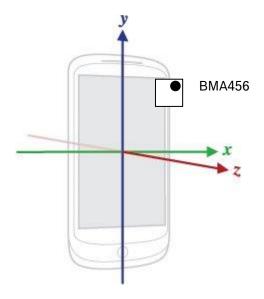
- ± 0g for the X channel
- ± 0g for the Y channel
- + 1g for the Z channel



The following table lists all corresponding output signals on X, Y, and Z while the sensor is at rest or at uniform motion in a gravity field under assumption of a ±4g range setting, a 16 bit resolution, and a top down gravity vector as shown above.

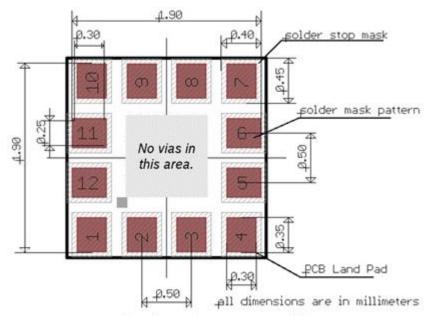
Sensor Orientation (gravity vector ↓)	•	•	•	•	unricht	tdginqu
Output Signal X	0g/0LSB	1g/8192 LSB	0g/0LSB	-1g/-8292 LSB	0g/0LSB	0g/0LSB
Output Signal Y	-1g/-8192 LSB	0g/0LSB	1g/8192 LSB	0g/0LSB	0g/0LSB	0g/0LSB
Output Signal Z	0g/0LSB	0g/0LSB	0g/0LSB	0g/0LSB	1g/8192 LSB	-1g/-8192 LSB

For reference the figure below shows the typical device orientation with an integrated BMA456.



8.3. Landing pattern recommendation

The recommended landing pattern for the BMA456 on customer's PCB is given in the following figure. It is recommended to avoid any wiring underneath the BMA456 (shaded area).



Landing pattern recommendation

8.4. Marking

Mass production

Labeling	Name	Symbol	Remark
	Counter ID	ccc	3 alphanumeric digits, variable to generate trace-code.
	Pin 1 identifier top side	•	
CCC			

Engineering samples

Labeling	Name	Symbol	Remark
	Eng. sample ID	E, N	2 alphanumeric digits, fixed to identify engineering sample, N = "C"
	Sample ID	СС	2 alphanumeric digits, variable to generate trace-code.
NCC	Pin 1 identifier top side	•	

8.5. Soldering guidelines

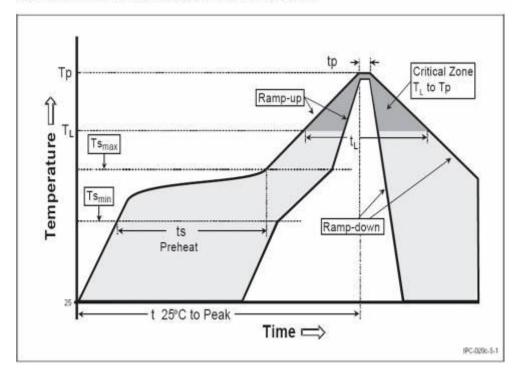
The moisture sensitivity level of the BMA456 sensors corresponds to JEDEC Level 1, see also

- IPC/JEDEC J-STD-020C "Joint Industry Standard: Moisture/Reflow Sensitivity Classification for non-hermetic Solid State Surface Mount Devices"
- IPC/JEDEC J-STD-033A "Joint Industry Standard: Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices"

The sensor fulfils the lead-free soldering requirements of the above-mentioned IPC/JEDEC standard, i.e. reflow soldering with a peak temperature up to 260°C.

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (Ts _{max} to Tp)	3° C/second max.
Preheat - Temperature Min (Ts _{min}) - Temperature Max (Ts _{max}) - Time (ts _{min} to ts _{max})	150 °C 200 °C 60-180 seconds
Time maintained above: - Temperature (T _L) - Time (t _L)	217 °C 60-150 seconds
Peak/Classification Temperature (Tp)	260 °C
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.



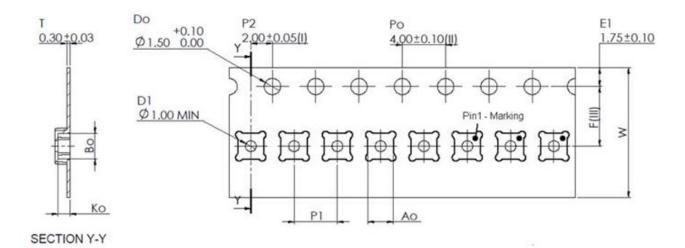
8.6. Handling instructions

Micromechanical sensors are designed to sense acceleration with high accuracy even at low amplitudes and contain highly sensitive structures inside the sensor element. The MEMS sensor can tolerate mechanical shocks up to several thousand g's. However, these limits might be exceeded in conditions with extreme shock loads such as e.g. hammer blow on or next to the sensor, dropping of the sensor onto hard surfaces etc.

We recommend to avoid g-forces beyond the specified limits during transport, handling and mounting of the sensors in a defined and qualified installation process.

This device has built-in protections against high electrostatic discharges or electric fields (e.g. 2kV HBM); however, anti-static precautions should be taken as for any other CMOS component. Unless otherwise specified, proper operation can only occur when all terminal voltages are kept within the supply voltage range. Unused inputs must always be tied to a defined logic voltage level.

8.7. Tape and Reel specification



Ao	2.35 +/- 0.05
Во	2.30 +/- 0.05
Ko	1.10 +/- 0.05
F	5.50 +/- 0.05
P1	4.00 +/- 0.10
W	12.00 +0.30 / -0.10

8.8. Environmental safety

The BMA456 sensor meets the requirements of the EC restriction of hazardous substances (RoHS) directive, see also:

Directive 2011/65/EU of the European Parliament and of the Council of 8 September 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Halogen content

The BMA456 is halogen-free. For more details on the corresponding analysis results please contact your Bosch Sensortec representative.

Internal package structure

Within the scope of Bosch Sensortec's ambition to improve its products and secure the mass product supply, Bosch Sensortec qualifies additional sources (e.g. 2nd source) for the LGA package of the BMA456.

While Bosch Sensortec took care that all of the technical packages parameters are described above are 100% identical for all sources, there can be differences in the chemical content and the internal structural between the different package sources.

However, as secured by the extensive product qualification process of Bosch Sensortec, this has no impact to the usage or to the quality of the BMA456 product.

9. Legal disclaimer

9.1. Engineering samples

Engineering Samples are marked with an asterisk (*) or (e). Samples may vary from the valid technical specifications of the product series contained in this data sheet. They are therefore not intended or fit for resale to third parties or for use in end products. Their sole purpose is internal client testing. The testing of an engineering sample may in no way replace the testing of a product series. Bosch Sensortec assumes no liability for the use of engineering samples. The Purchaser shall indemnify Bosch Sensortec from all claims arising from the use of engineering samples.

9.2. Product use

Bosch Sensortec products are developed for the consumer goods industry. They may only be used within the parameters of this product data sheet. They are not fit for use in life-sustaining or safety-critical systems. Safety-critical systems are those for which a malfunction is expected to lead to bodily harm, death or severe property damage. In addition, they shall not be used directly or indirectly for military purposes (including but not limited to nuclear, chemical or biological proliferation of weapons or development of missile technology), nuclear power, deep sea or space applications (including but not limited to satellite technology).

The resale and/or use of Bosch Sensortec products are at the purchaser's own risk and his own responsibility. The examination of fitness for the intended use is the sole responsibility of the purchaser.

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The purchaser accepts the responsibility to monitor the market for the purchased products, particularly with regard to product safety, and to inform Bosch Sensortec without delay of all safety-critical incidents.

9.3. Application examples and hints

With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Bosch Sensortec hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights or copyrights of any third party. The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. They are provided for illustrative purposes only and no evaluation regarding infringement of intellectual property rights or copyrights or regarding functionality, performance or error has been made.

10. Document history and modification

Rev. No	Chapter	Description of modification/changes	Date
1.0	-	Document creation	07 Aug 2017
1.1	8.1	Update	26 Oct 2017
2.0	All	Restructuring of Data sheet, Feature set is described in separate application note	17 Sept 2019
	1.0	Added Temperature Sensor Spec	
	4.4	added ODR table with current consumption	
	4.5, 4.6, 4.8, 4.9	Minor updates	
	4.12	Added NVM lock explanation	
	5.2	Restructuring & minor updates	
	6.2	Updated CSB pin-out in I ² C mode, Updated Interface capacitance (minor)	
	6.4, 6.5, 6.6	Updated SPI and I ² C Interface timings (minor)	
	6.5	Improved images	
	7.1	Updated CSB pin-out in I ² C mode	
	7.2	Summarized DS infos added for ease of use	
	9	Updated Disclaimer	



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Preliminary - specifications subject to change without notice
Document number: BST-BMA456-DS002-00
Revision_2.0_082019